## خزش Creep

## منابع درسی

1- Fundamental of creep in metals and alloys By M. Kassner

2- Mechanical metallurgy By <u>G. Dieter</u>

3-Mechanical properties and working of metals and alloys By A. Bhaduri

4-Creep-resistant steels
By F. Abe, T.-Ulf Kern and R. Viswanathan

### بارم بندی کلاس

۱ – فعالیت کلاسی

۲- تمارین کلاسی

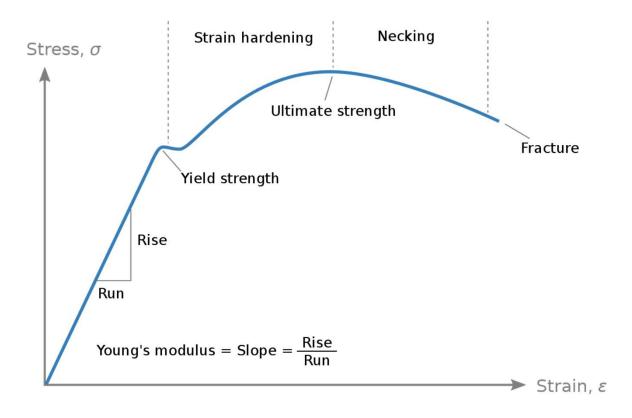
۳– سمینار

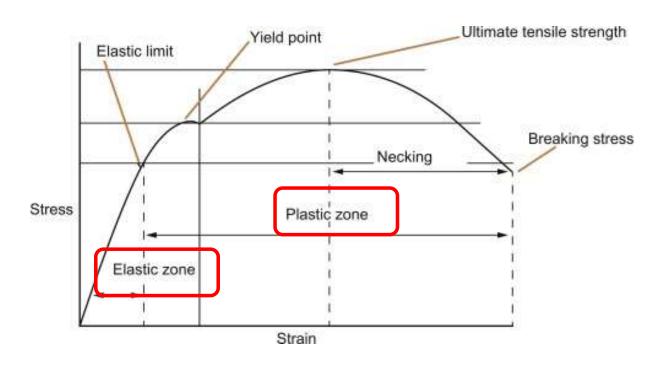
۴– پایان ترم

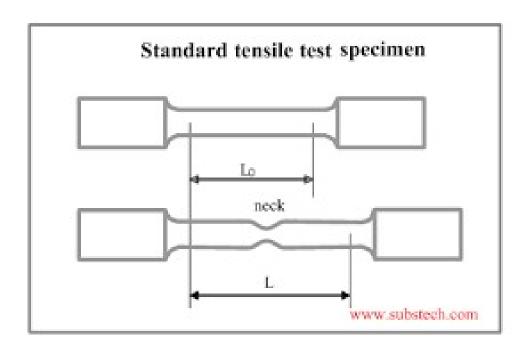
### مباحث مقدماتي

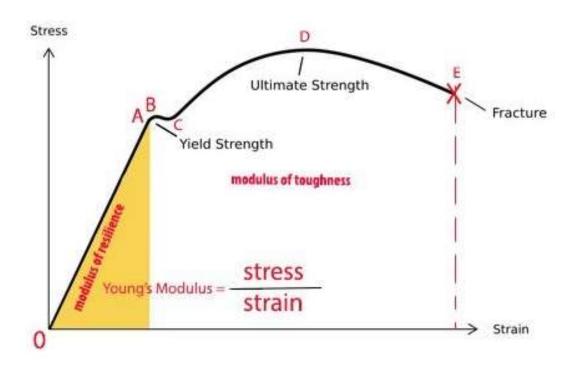
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- مدول یانگ
- چقرمگی
- برجهندگی

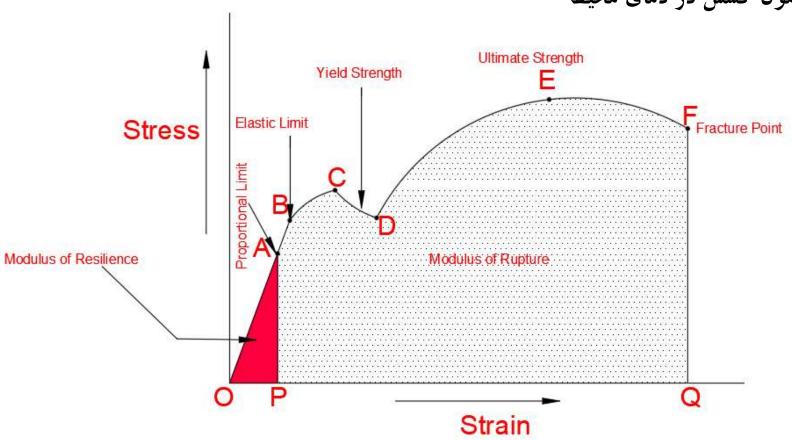
استحکام در دمای پایین و تست کشش



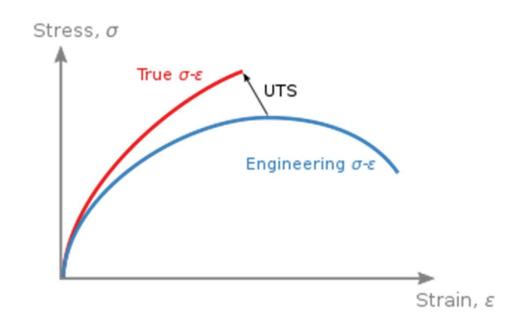








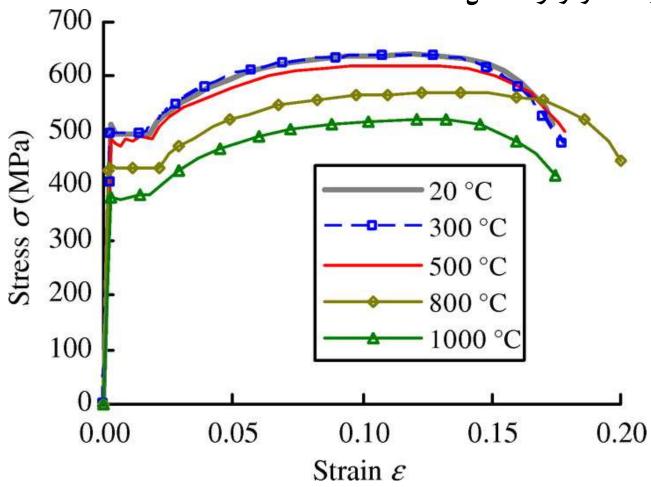
### نمودار تنش-کرنش مهندسی و تنش-کرنش واقعی



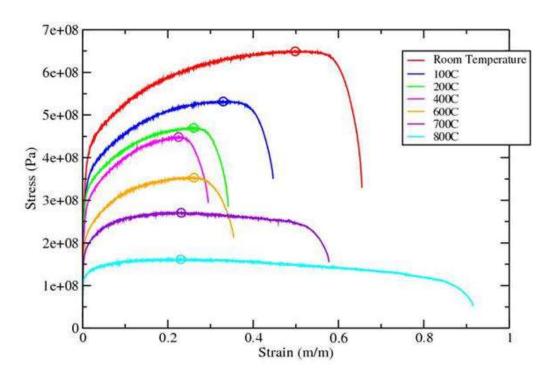
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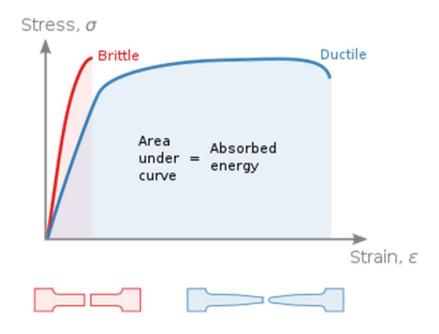
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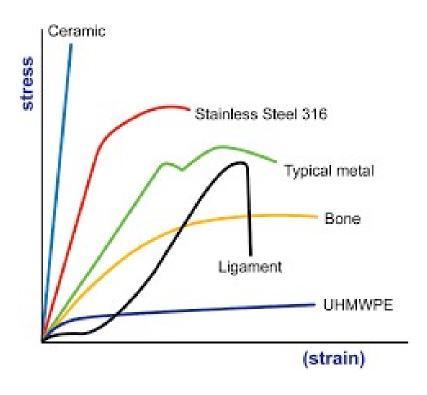
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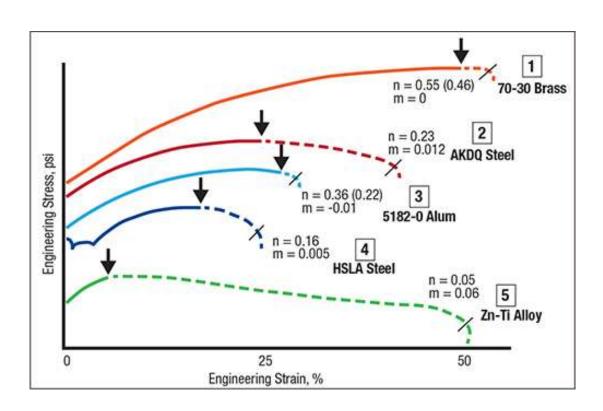
### رفتار متفاوت مواد در برابر یک نیروی کششی



### رفتار متفاوت مواد در برابر یک نیروی کششی



### رفتار متفاوت مواد در برابر یک نیروی کششی



### تغییر شکل در مواد

۱- تغییر شکل مستقل از زمان-تغییر شکل دائم (Plastic)

-تغييرشكل موقت (Elastic)

۲- تغییرشکل وابسته به زمان

- -تغییر شکل دائم (Creep)

-تغییرشکل موقت (Inelastic)

### Creep

- Materials in service are often exposed to elevated temperatures or static loads for long duration of time.
- Deformation under such circumstances may be termed as creep.
- Time-dependent deformation of a material while under an applied load that is below its yield strength.
- Mostly occurs at elevated temperature though some materials creep at room temperature.
- Creep is a deformation mechanism that may or may not constitute a failure mode.

### Creep

- Creep is a time-dependent process where a material under an applied stress exhibits a dimensional change at high temprature.
- High temperature progressive deformation of a material at constant stress is called creep.
- The process is also temperature-dependent
- Creep always increases with temperature.

### كاربرد خزش



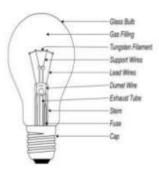
Oil Refinery



Steam turbine used in power plant

### **High Temperature Applications**

Components exposed to high temperature.



Sagging of the filament coil increases with time due to creep deformation caused by the weight of the filament. Too much deformation--the adjacent turns of the coil touch one another--causing an electrical short and local overheating, which quickly leads to failure of the filament



# Chapter 1 Introduction

### High temperature affects these parameters:

- Oxidation: environment + metal
- Slip system
- Phase transformation
- Vibration of atoms (bond energy and elastic modulus
- Climb of dislocation
- Diffusion (Xv)
- Grain growth
- Over aging
- Shear of precipitated particles
- Solving the precipitated particles in the matrix
- Thermal expansion

All resulted in decreased in strength

### **DESCRIPTION OF CREEP**

Creep of materials is classically associated with time-dependent plasticity under a fixed stress at an elevated temperature, often greater than roughly 0.5 Tm, where Tm is the absolute melting temperature.

## Introduction to Creep Behavior

#### Definition of creep in materials science

Creep is the slow, time-dependent deformation of materials under constant stress, particularly at elevated temperatures. It is a critical concern in materials science due to its impact on the strength and lifespan of materials.

### Importance of understanding creep behavior in engineering applications

Creep behavior is essential for predicting material performance over time, ensuring safety and reliability in engineering applications such as power generation, aerospace, and automotive industries.



### At what temperature the material will creep?

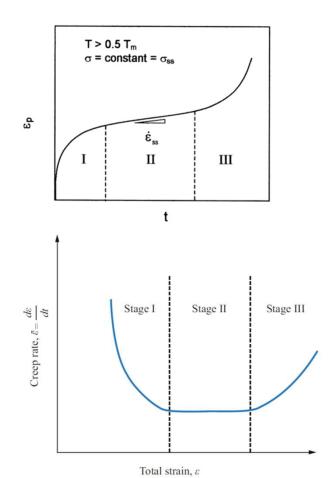
- Different metals have different melting temperatures. e.g. Pb 327°C, W 3407°C.
- Material will creep when the temperature will be > 0.5Tm (Tm = absolute melting temperature).

Metal	Melting temp.		0.5xMelting Temp	
Lead	327°C	600°K	327°K	27°C
W	3407	3680	1840	1567

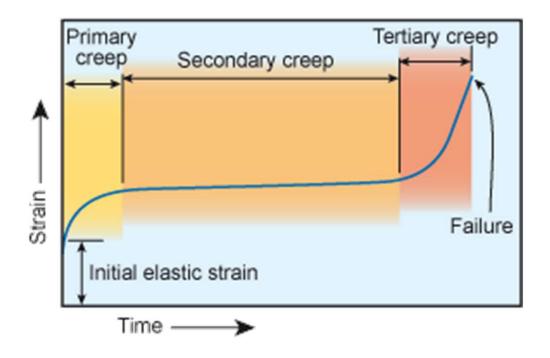
### Ideal creep curve

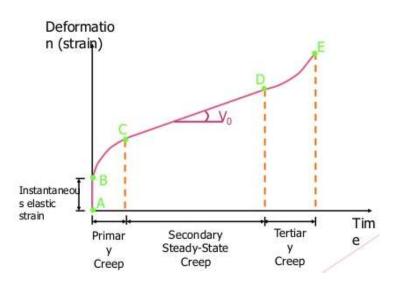
Three regions are delineated:

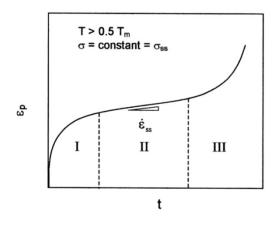
- 1- Stage I, or primary creep, which denotes that portion where the creep-rate (plastic strain-rate),  $d\epsilon/dt$  is changing with increasing plastic strain or time.
- 2- Constant strain-rate conditions (Stage II, secondary, or steady-state creep), de/dt is constant with increasing plastic strain or time hardens.
- 3- Cavitation and/or cracking increase the apparent strain-rate or decrease the flow stress. This regime is termed Stage III, or tertiary creep, and leads to fracture.

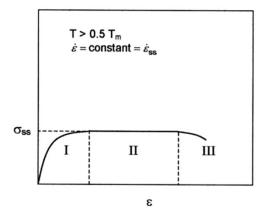


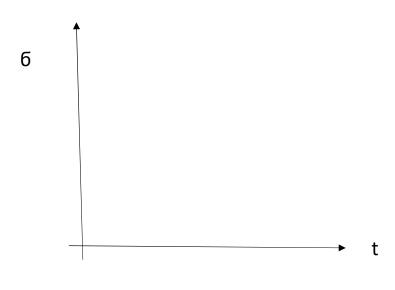
### خزش











## Stress rate-strain rate effect

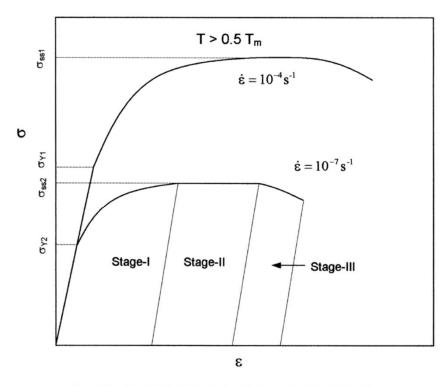


Figure 2. Creep behavior at two different constant strain-rates.

Temperature effect

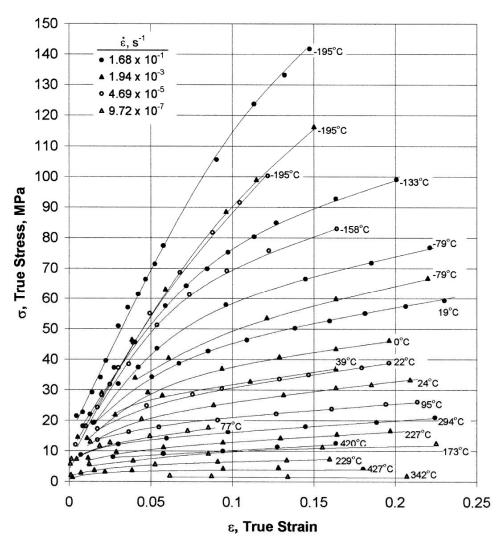
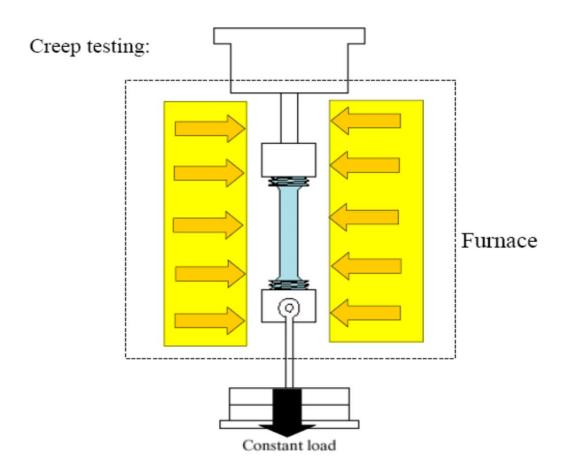
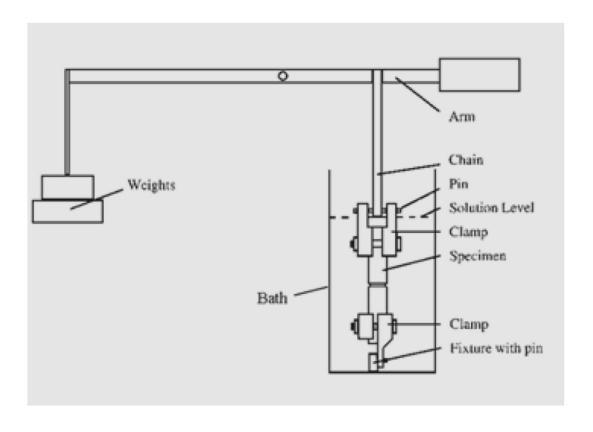


Figure 5. The stress versus strain behavior of high-purity aluminum. Data from Ref. [15].

### Creep

Creep is a time-dependent and permanent deformation of materials when subjected to a constant load at a high temperature ( $> 0.4~T_{\rm m}$ ). Examples: turbine blades, steam generators.







### **Creep Design**

In high-temperature design it is important to make sure:

- (a) that the creep strain  $\varepsilon^{cr}$  during the design life is acceptable;
- (b) that the creep ductility  $\varepsilon_f^{cr}$  (strain to failure) is adequate to cope with the acceptable creep strain;
- (c) that the time-to-failure,  $t_f$ , at the design loads and temperatures is longer (by a suitable safety factor) than the design life.

Mechanical & Aerospace Engineering

### Factors Influencing Creep Behavior



### The impact of temperature on creep rates

Typically, as temperature rises, the creep rate increases exponentially as thermal activation enhances atomic mobility, leading to greater deformation over time.

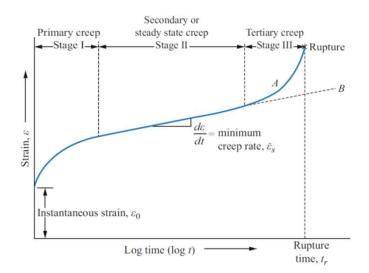
### Effect of stress levels and material properties

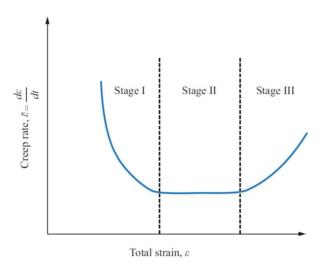
Higher applied stresses magnify creep rates in materials.

Additionally, material properties such as strength, ductility, and microstructure play vital roles in determining overall creep resistance.

### Influence of time and environmental conditions on creep

Long exposure times and varying environmental conditions (e.g., corrosive environments) can significantly alter creep behavior, leading to unexpected failures if not accounted for.





**Fig. 7.2** Constant-temperature typical creep curve showing the three distinct stages of creep. Curve 'A' for constant-load test and curve 'B' for constant-stress test

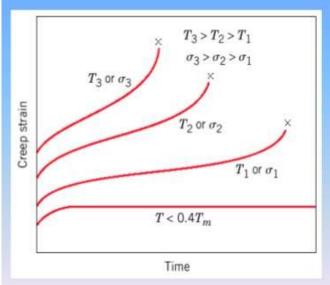
Fig. 7.3 Creep rate as a function of total strain

€=f (T, SIGMA, t)

## Sample deformation at a constant stress (σ) vs. time

- 1.Instantaneous deformation: Mainly elastic.
- Primary/transient creep: Slope of strain vs. time decreases with time: work-hardening
- Secondary/steady-state creep: Rate of straining is constant: balance of work-hardening and recovery.
- 4. Tertiary/Rapidly accelerating strain rate up to failure: Formation of internal cracks, voids, grain boundary, separation, necking, etc.

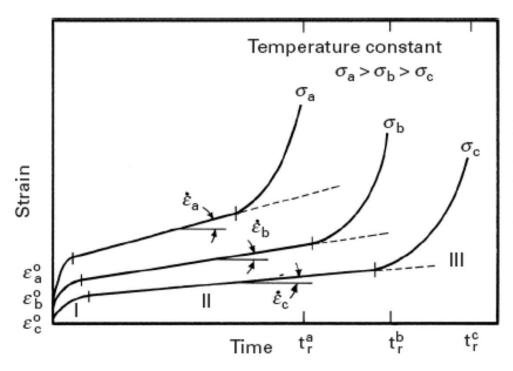
## Creep: stress and temperature effects



With Increasing stress or temperature:

- The instantaneous strain increases
- The steady-state creep rate increases
- The time to rupture decreases

## $E_{ffects\ of\ Temperature\ on\ Creep}$



- ➤ The instantaneous strain increases
- ➤ The steady-state creep rate increases
- ➤ The time to rupture decreases

# Basic Mechanisms of Creep

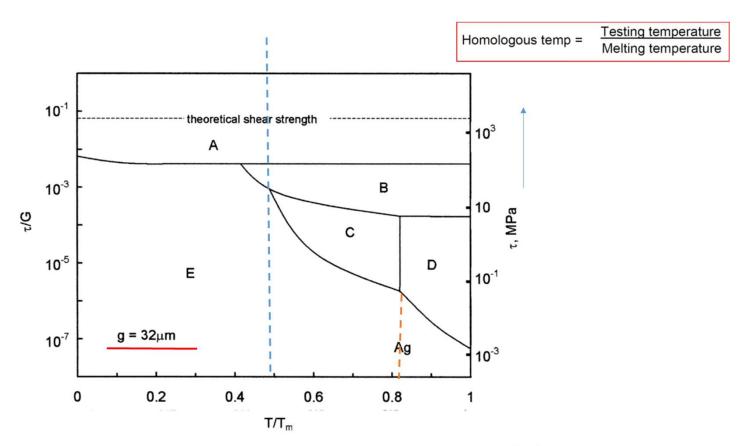
Explanation of key creep mechanisms: dislocation movement, diffusion, and grain boundary sliding

Creep occurs through several key mechanisms: dislocation movement (where lattice defects move), diffusion (atomic movement that allows material rearrangement), and grain boundary sliding (where grains slide past each other).

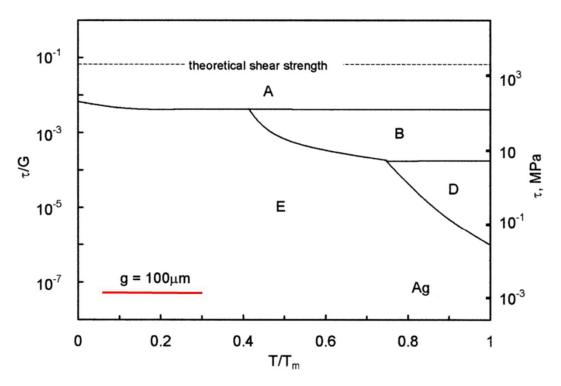


## **Mechanisms of Creep**

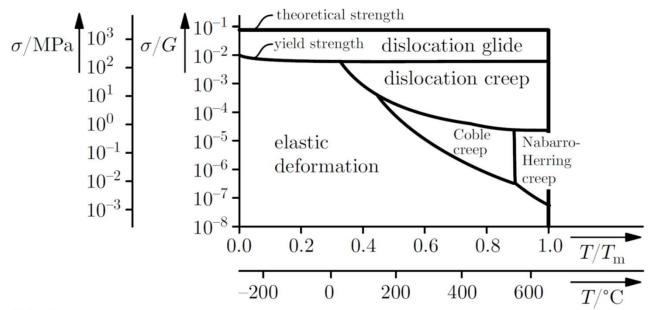
- Different mechanisms are responsible for creep in different materials and under different loading and temperature conditions. The mechanisms include
- · Stress-assisted vacancy diffusion
- Grain boundary diffusion (diffusion creep)
- · Grain boundary sliding
- Dislocation Glide
- Dislocation creep



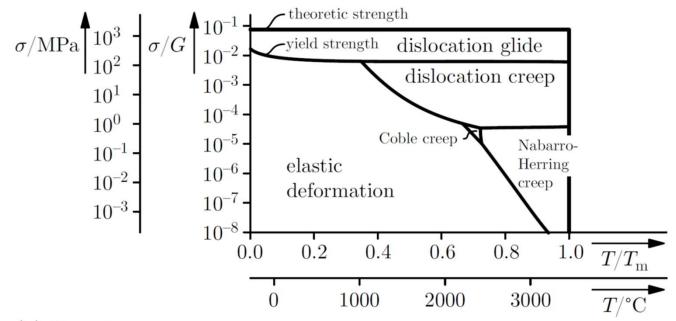
**Figure 6.** Ashby deformation map of silver from [33]. grain sizes 32 and 100  $\mu \underline{m}$ ,  $\dot{\epsilon} = 10^{-8} \, \text{s}^{-1}$ , A – dislocation glide, B – Five-Power-Law Creep, C – Coble creep, D – Nabarro-Herring creep, E – elastic deformation.



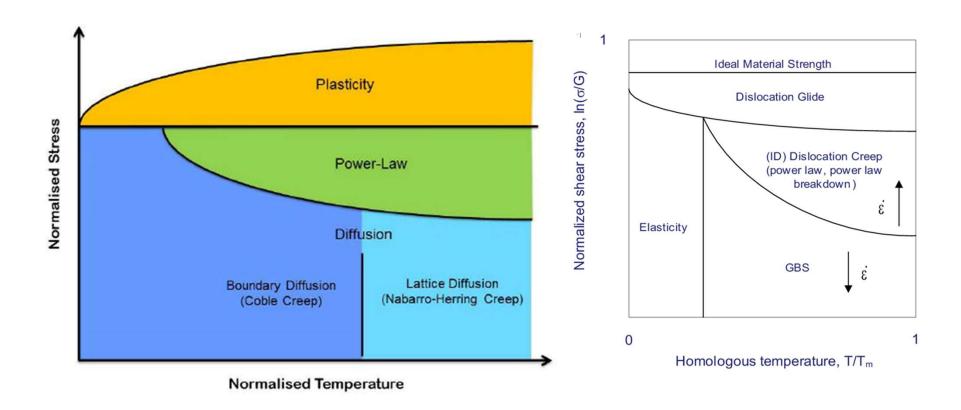
**Figure 6.** Ashby deformation map of silver from [33]. grain sizes 32 and 100  $\mu$ m,  $\dot{\epsilon} = 10^{-8} \, \text{s}^{-1}$ , A – dislocation glide, B – Five-Power-Law Creep, C – Coble creep, D – Nabarro-Herring creep, E – elastic deformation.

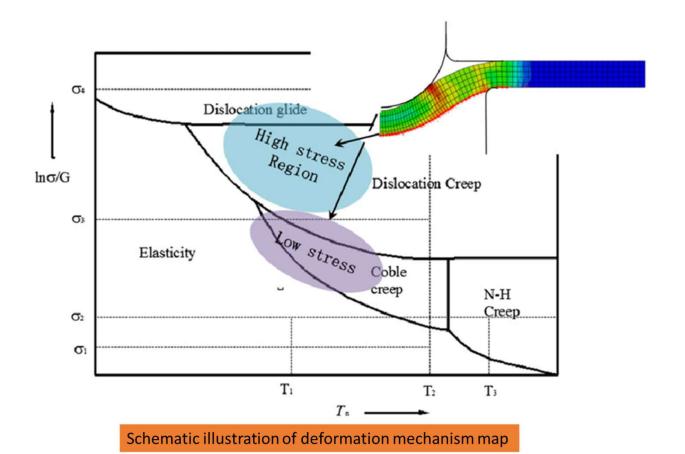


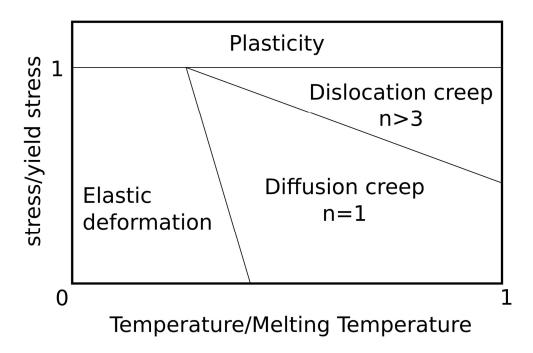
(a) Aluminium grain size is  $32 \,\mu\mathrm{m}$ 



(b) Tungsten grain size is  $32 \,\mu m$ 

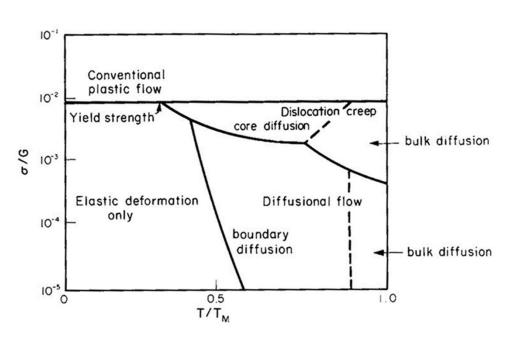






Example of an Ashby deformation mechanism map

## **Deformation Maps**



From: Ashby & Jones

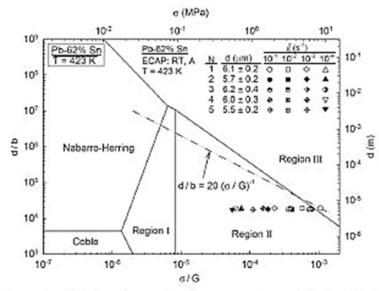
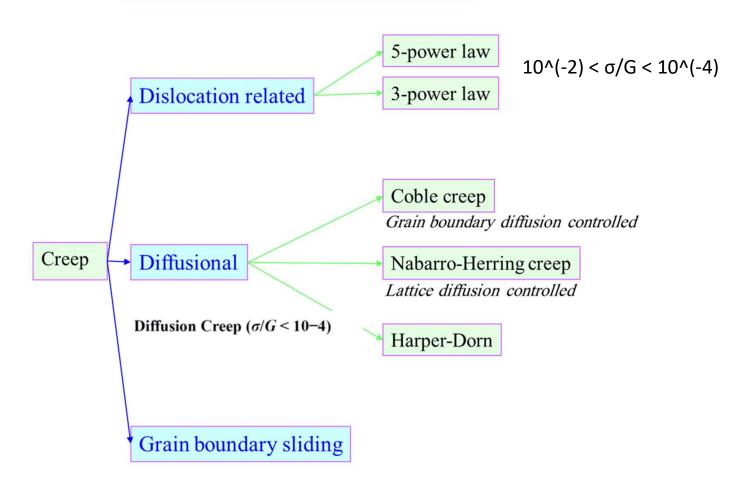


Figure 6. A deformation mechanism map of normalized grain size versus normalized stress for a Pb-62% Sn alloy tested at 423 K<sup>37</sup>.

## Creep Mechanisms of crystalline materials



## Chapter 3

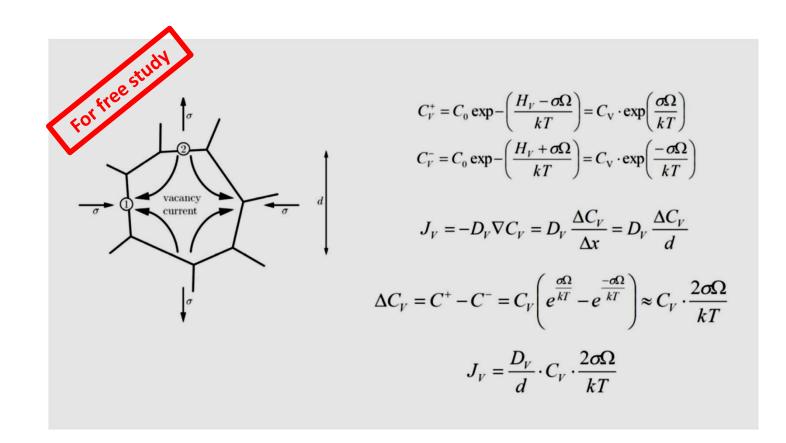
## **Diffusional-Creep**

Creep at high temperatures ( $T \approx T_{\rm m}$ ) and very low stresses in fine-grained materials was attributed 50 years ago by Nabarro [237] and Herring [51] to the mass transport of vacancies through the grains from one grain boundary to another. Excess vacancies are created at grain boundaries perpendicular to the tensile axis with a uniaxial tensile stress. The concentration may be calculated using [23]

$$n_{\nu} = n \exp\left(\frac{Q_{\nu}}{RT}\right)$$
  $c = c_{\nu} \left[\exp\left(\frac{\sigma b^3}{kT}\right) - 1\right]$  (76)

where  $c_v$  is the equilibrium concentration of vacancies. Usually  $(\sigma b^3/kT) \propto 1$ , and therefore equation (76) can be approximated by

$$c = \left[ c_v \left( \frac{\sigma b^3}{kT} \right) \right] \tag{77}$$



## **Coble creep mechanism**

a form of diffusion creep, is a mechanism for deformation of crystalline solids. Coble creep occurs through the diffusion of atoms in a material along the grain boundaries, which produces a net flow of material and a sliding of the grain boundaries.

Coble creep is named after Robert L. Coble, who first reported his theory of how materials creep over time in 1962 in the Journal of Applied Physics.

This mechanism is particularly significant in fine-grained materials and at intermediate to high temperatures

0.5 Tm<T<0.8 Tm

## **Coble creep mechanism**

The strain rate  $(\dot{\epsilon})$  in Coble creep is described by the following relationship:

$$\dot{\epsilon} = rac{A\sigma\Omega D_{gb}\delta}{d^3kT}$$

#### Where:

- $\dot{\epsilon}$ : Strain rate (rate of deformation).
- ullet A: A dimensionless constant that depends on the material and microstructure.
- $\sigma$ : Applied stress.
- $\Omega$ : Atomic volume.
- ullet  $D_{gb}$ : Grain boundary diffusion coefficient.
- $\delta$ : Grain boundary width (typically a few atomic spacings).
- d: Grain size.
- k: Boltzmann constant.
- ullet T: Absolute temperature.

## Coble mechanism

The strain-rate suggested by Coble is

$$\dot{\varepsilon}_{\rm ss} = \frac{\alpha_3 D_{gb} \sigma b^4}{k T g^3}$$

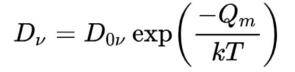
$$\dot{\epsilon} = rac{ADGb}{kT} {(rac{\sigma}{G})}^n {(rac{b}{d})}^p$$

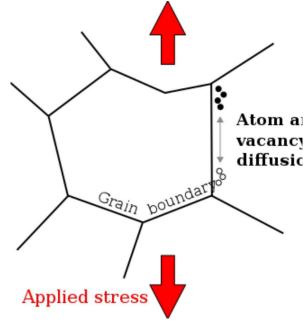
$$\mathsf{g}$$
  $\dot{\epsilon}$ 

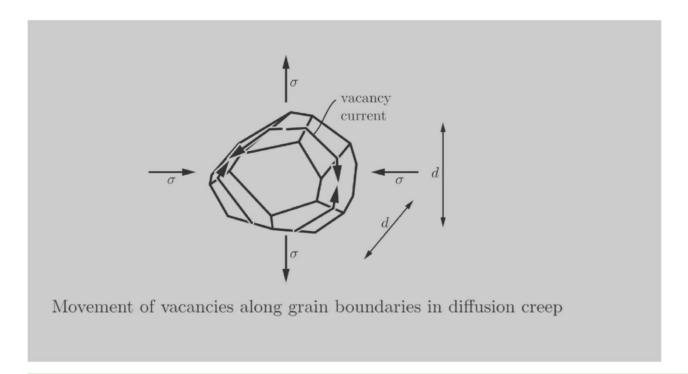
#### The **Boltzmann constant**

 $1.380649 \times 10^{-23[2]}$ 

J.K-1







- Under an applied stress, atoms migrate from grain boundaries experiencing compressive stress to those experiencing tensile stress.
- Grain boundaries have a more disordered atomic structure compared to the crystalline lattice, making them high-diffusivity pathways.

## **Nabarro-Herring Creep Mechanism**

Nabarro-Herring creep is a diffusion-controlled creep mechanism that occurs in crystalline materials at very high temperatures. It is characterized by the diffusion of atoms through the crystal lattice (bulk diffusion) under an applied stress. This mechanism is particularly significant in coarse-grained materials and at temperatures close to the melting point.

## Nabarro and Herring mechanism

The strain rate  $(\dot{\epsilon})$  in Nabarro-Herring creep is described by the following relationship:

$$\dot{\epsilon} = rac{A\sigma\Omega D_l}{d^2kT}$$

#### Where:

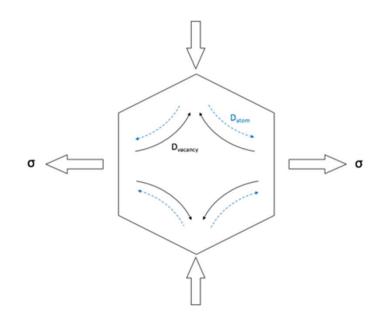
- $\dot{\epsilon}$ : Strain rate (rate of deformation).
- ullet A: A dimensionless constant that depends on the material and microstructure.
- $\sigma$ : Applied stress.
- $\Omega$ : Atomic volume.
- ullet  $D_l$ : Lattice diffusion coefficient.
- d: Grain size.
- k: Boltzmann constant.
- ullet T: Absolute temperature.

## Nabarro and Herring mechanism

The resulting strain-rate is given by,

$$\dot{\varepsilon}_{\rm ss} = \frac{D_{\rm sd}\sigma b^3}{{\rm k}Tg^2}$$

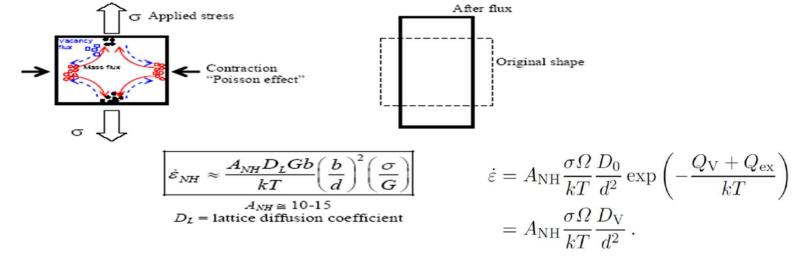
$$\dot{\epsilon}_{NH} = A_{NH} \left(rac{D_L}{d^2}
ight) \left(rac{\sigma\Omega}{kT}
ight)$$

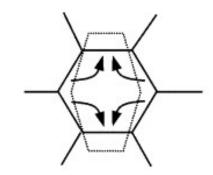


where  $A_{NH}$  is a constant that absorbs the approximations in the derivation.

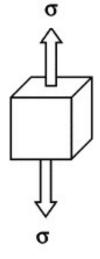
#### Nabarro-Herring Creep

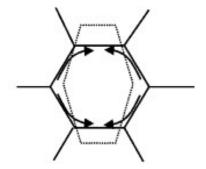
- · Occurs solely by diffusional mass transport.
- Is important for much <u>higher T's</u> and <u>lower σ's</u> than was the case for <u>dislocation glide creep</u>.
- · Can occur in crystalline and amorphous materials.
- \* Applied stress creates tensile and compressive regions.
  - Concentration of vacancies in tensile region > compressive
  - Vacancy concentration gradient → diffusion
  - Diffusion leads to shape change





(a): Nabarro - Herring Creep





(b) : Coble Creep

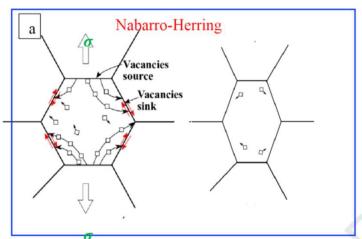
Mechanism	favorable conditions	Description	A	n	р
Nabarro-Herring creep	High temperature, low stress and small grain size	Vacancy diffusion through the crystal lattice	10- 15	1	2
Coble creep	Low stress, fine grain sizes and temperature less than those for which NH creep dominates	Vacancy diffusion along grain boundaries		1	3

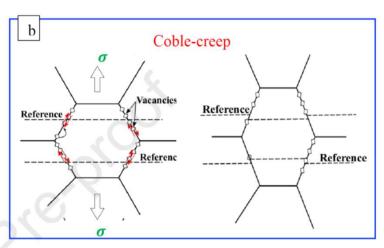
## **Key Differences Summary**

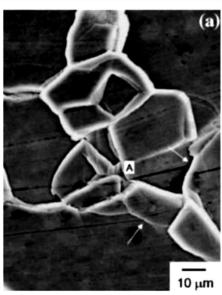
Feature	Coble Creep	Nabarro-Herring Creep
Diffusion Pathway	Grain boundary diffusion	Lattice (bulk) diffusion
Grain Size Dependence	$\propto rac{1}{d^3}$	$\propto rac{1}{d^2}$
Temperature Range	Intermediate to high temperatures	Very high temperatures
Activation Energy	Lower (grain boundary diffusion)	Higher (lattice diffusion)
Microstructural Role	Grain boundaries are critical	Bulk lattice is critical

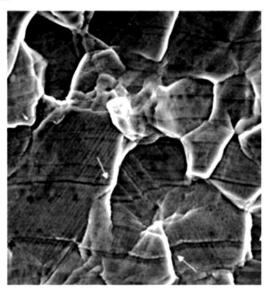
Coble creep is important in materials used at high temperatures, such as turbine blades, nuclear reactors, and aerospace components.

## Nabarro-Herring Creep vs. Coble Creep









# Chapter 4

# Harper-Dorn Creep

is a low-stress, high-temperature creep mechanism observed in certain crystalline materials, particularly in high-purity metals like aluminum.

It was first identified by Harper and Dorn in 1957 during experiments on pure aluminum at temperatures close to its melting point and under very low stresses.

This mechanism is characterized by a stress exponent of approximately 1, indicating a linear relationship between the applied stress and the strain rate, which distinguishes it from other creep mechanisms like power-law creep.

The strain rate  $(\dot{\epsilon})$  in Harper-Dorn creep is linearly proportional to the applied stress  $(\sigma)$ , expressed as:

 $\dot{\epsilon} \propto \sigma$ 

#### **Experimental Conditions**

- Material: High-purity aluminum (99.999% pure).
- **Temperature**: Very high homologous temperature ( $T>0.9T_m$ ), where  $T_m$  is the melting temperature of aluminum (933 K or 660°C). For example, experiments were conducted at around **850 K (577°C)**.
- Stress: Very low applied stresses, typically in the range of **0.1 to 1 MPa**.
- **Grain Size**: Coarse-grained or single-crystal aluminum to minimize the influence of grain boundaries.

#### 3.3 mm grain size

$$\dot{\varepsilon}_{\rm ss} = A_{\rm HD} \left( \frac{D_{\rm sd} G b}{kT} \right) \left( \frac{\sigma}{G} \right)^{1}$$

where  $A_{HD}$  is a constant.

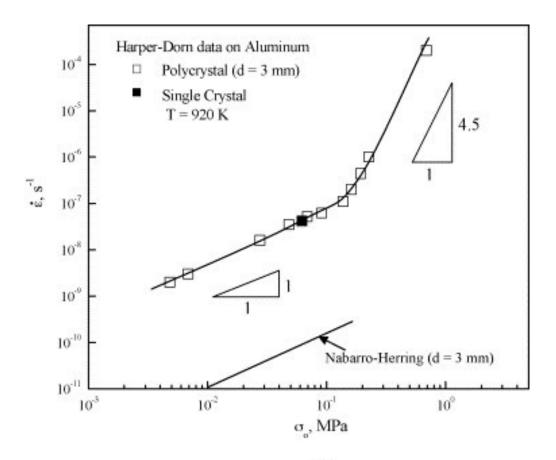
#### **Harper-Dorn creep**

- Harper-Dorn creep occurs at **very high homologous temperatures** (typically above 0.9  $T_m$ , where  $T_m$  is the melting temperature).
- The activation energy for Harper-Dorn creep is close to that of lattice self-diffusion,
   suggesting that atomic diffusion plays a significant role in the deformation process

Harper-Dorn creep often exhibits a primary creep stage, where the strain rate decreases over time before reaching a steady state. This is attributed to the gradual stabilization of the dislocation network.

**Figure 50.** Comparison between the diffusion-coefficient compensated strain-rate versus modulus-compensated stress for pure aluminum based on [50,269,294], with theoretical predictions for Nabarro–Herring creep [295].

 $\sigma_{ss}/G$ 



$$\dot{\mathbf{\varepsilon}}_{\rm ss} = \mathbf{A}_{10} \frac{D_{\rm eff}}{b^2} \left(\frac{\mathbf{\sigma}}{E}\right)^n$$

The dislocation density in Harper-Dorn creep remains constant and independent of the applied stress. This is a unique feature that differentiates it from other creep mechanisms, where dislocation density typically increases with stress.

## **Comparison with Other Creep Mechanisms**

Feature	Harper-Dorn Creep	Nabarro-Herring Creep	Coble Creep	Power-Law Creep
Stress Exponent (n)	1	1	1	3-5
Temperature Range	Very high ( $>$ $0.9T_m$ )	High ( $>0.6T_m$ )	Intermediate to high	High ( $>0.6T_m$ )
Grain Size Dependence	Independent	$d^{-2}$	$d^{-3}$	Weak dependence
Dislocation Density	Constant	Not applicable	Not applicable	Increases with stress

# Chapter 6 Superplasticity

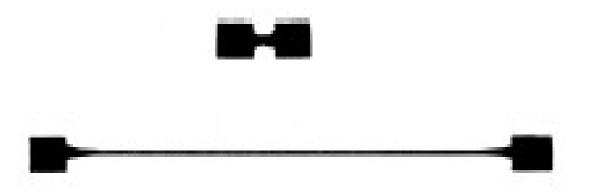
# Superplasticity

- •Superplasticity is the ability to withstand very large deformation in tension without necking.
- •Give elongation > 1000%.
- •Materials with high strain rate sensitivity (m) at high temperature
   (T>0.5T<sub>m</sub>) → superplasticity
- Materials characteristics: *fine grain size* (<10 μm) with the presence of **second phase of similar strength to the matrix** to inhibit grain growth and to avoid extensive internal cavity formation.
- Grain boundary should be high angle and mobile to promote grain boundary sliding and to avoid the formation of local stress concentration respectively.

 Superplastic deformation can be utilized to help shape complex geometry at high temperatures

# Superplasticity

strain rate of 10-3 -10-5 s-1



Superplastic tensile deformation in Pb–62% Sn eutectic alloy tested at 415 K and a strain rate of 1.33  $\times$  10–4 s–1; total strain of 48.5.

Grain-boundary sliding. It is a shear process occurring in the direction of grain boundary, causing the movement of grains relative to each other in polycrystals. Grain boundaries lying at about 45° to the applied tensile stress will experience the maximum shear stress and slide the most. It is encouraged by decreasing the strain rate and/or increasing the temperature.

$$\sigma \geq 10^{-2}G$$
.

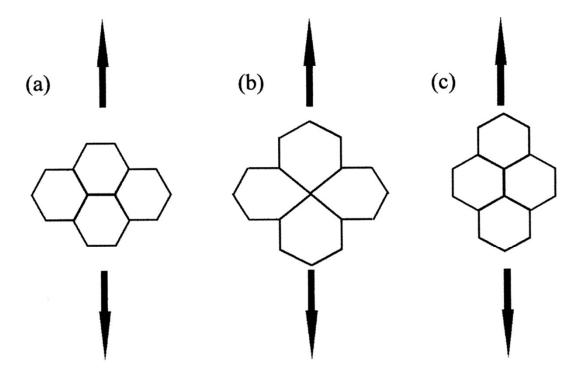
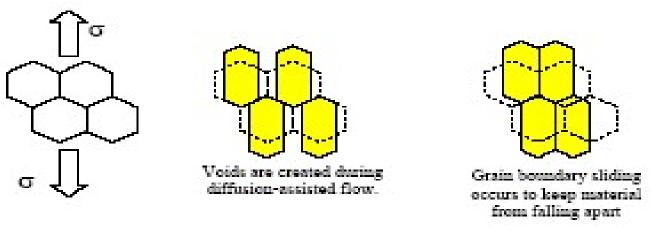


Figure 58. Ashby-Verral model of GBS accommodated by diffusional flow [436].

دانه ها نباید کروی باشند و حتها باید گوشه ای باشند

# Grain Boundary Sliding

One of the processes to accommodate grain-boundary strain at elevated temperature is grain-boundary migration.



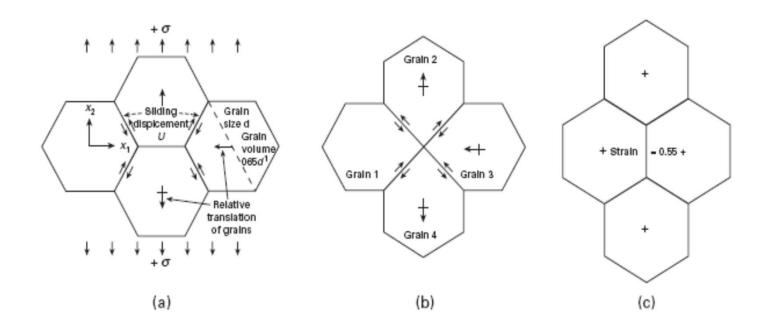
GB sliding occurs in conjunction with the NH & Coble creep mechanisms

GB sliding is thought to be the mechanisms that allows a material to extend in length with no net change in grain size during superplastic forming operations لغزش مرزدانهای یکی از مکانیزمهای تغییرشکل مواد در اثر حرکت دانهها نسبت به یکدیگر در دمای همولوگ بالا و سرعت کرنش پایین است. این مکانیزم نقش عمدهای در خزش و سوپرپلاستیسیتهٔ ریز ساختار دارد.

شبکهٔ مرزدانه ای در فرآیندهایی از قبیل مهاجرت مرزدانه، مهاجرت فصل مشترک سه تایی، چرخش دانه ها و فعالیت نابجایی در خود مرزدانه یا به کمک نابجایی های شبکه به لغزش مرزدانه نیاز دارد. مکانیزم اصلی لغزش مرزدانه ای حرکت نابجایی ها در اثر لغزش و صعود آنها در اطراف مرزدانه هاست.

میزان لغزش مرزدانه ای وابسته به تنش و نوع ماده موجب ایجاد کرنش صفر تا ۵۰ درصد می شود. با ایجاد رسوب و فاز های سخت مثل انواع کاربیدها در مرز سه دانه و موجی کردن مرزدانه می توان جلوی این مکانیزم را گرفت.

# Ashby-Verrall's Model



## Grain-boundary sliding assisted by diffusion in Ashby–Verrall's model.

(Reprinted with permission from M. F. Ashby and R. A. Verrall, *Acta Met.*, 21 (1973) 149.)

### **Grain-boundary sliding**

### **Grain Size Dependence:**

- GBS is more pronounced in **fine-grained materials** because the increased grain boundary area provides more pathways for sliding.
- $\circ$  The strain rate due to GBS is inversely proportional to the grain size (d), often following a relationship like  $\dot{\epsilon} \propto d^{-p}$ , where p is typically 2–3.

#### **Stress Dependence:**

 $\circ$  The strain rate due to GBS is proportional to the applied stress ( $\sigma$ ), often following a power-law relationship:

$$\dot{\epsilon} \propto \sigma^n$$

where the stress exponent n is typically 1–2.

### **Grain-boundary sliding**

The strain rate  $(\dot{\epsilon})$  due to grain boundary sliding can be expressed as:

$$\dot{\epsilon} = A rac{\sigma \Omega D_{gb} \delta}{d^p k T}$$

#### Where:

- A: A dimensionless constant.
- $\sigma$ : Applied stress.
- $\Omega$ : Atomic volume.
- ullet  $D_{gb}$ : Grain boundary diffusion coefficient.
- $\delta$ : Grain boundary width.
- d: Grain size.
- p: Grain size exponent (typically 2–3).
- k: Boltzmann constant.
- ullet T: Absolute temperature.

$$\dot{\epsilon}_{\rm SS} = {\rm K}_2(b/g)^{p'} D(\sigma/E)^2$$

Figure 59. Ball-Hutchinson model of GBS accommodated by dislocation movement [443].

$$\dot{\varepsilon}_{ss} = K_3 (b/g)^2 D_{sd} (\sigma/E)^2$$

$$\dot{\varepsilon}_{ss} = K_4 (b/g)^3 D_{gb} (\sigma/E)^2$$

# Superplastic flow

The **superplastic flow** is given by

$$\dot{\varepsilon} = 10^8 \left(\frac{\sigma}{E}\right)^2 \frac{bD_{gb}}{\overline{L}^3}$$

Eq.3 For grain boundary diffusion

$$\varepsilon = 2 \times 10^9 \left(\frac{\sigma}{E}\right)^2 \frac{D_o}{\overline{L}^2}$$

Eq.3 For lattice self-diffusion

Where  $\overline{L}$  is the mean linear intercept measure of grain size. in this case n = 2,  $\rightarrow m = 0.5$ 

The predominant mechanism for superplasticity deformation is *grain-boundary sliding* accommodated by slip.

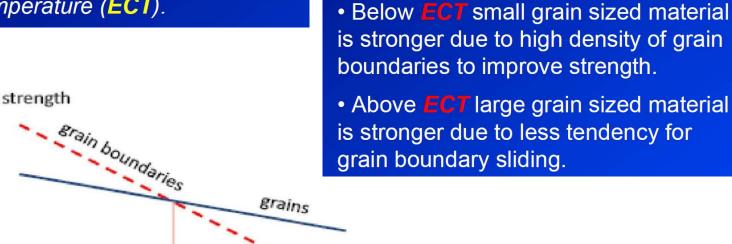
## **Comparison with Other Creep Mechanisms**

Feature	Grain Boundary Sliding (GBS)	Nabarro- Herring Creep	Coble Creep	Dislocation Creep
Dominant Mechanism	Sliding along grain boundaries	Lattice diffusion	Grain boundary diffusion	Dislocation motion
Grain Size Dependence	$d^{-2}$ to $d^{-3}$	$d^{-2}$	$d^{-3}$	Weak dependence
Temperature Range	Intermediate to high	High	Intermediate to high	High
Stress Exponent (n)	1–2	1	1	3-5

در دماهای پایین مرزهای دانه مستحکم اند . با افزایش دما ، مرز های دانه شروع به ذوب شدن کرده و حالت نرم پیدا می کنند . به دلیل وجود تنش برشی اعمالی بر روی جسم و نرم شدن مرز های دانه ، مرز های دانه در کنار هم می لغزند و موجب تغییر شکل در ساختار کریستالی ماده می گردند.

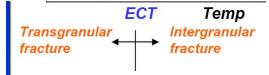
# Equicohesive temperature

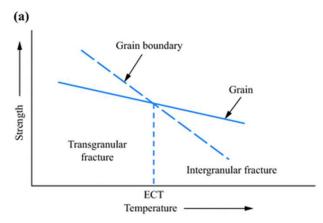
• Strength of **GB** = **grain** at the equicohesive temperature (**ECT**).

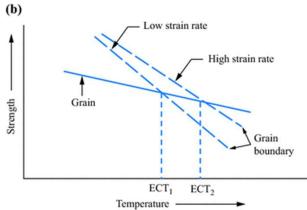


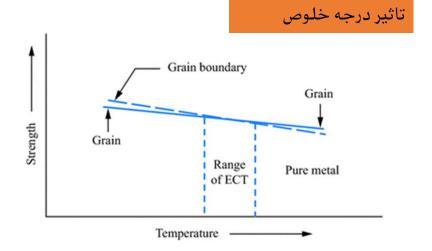
temperature

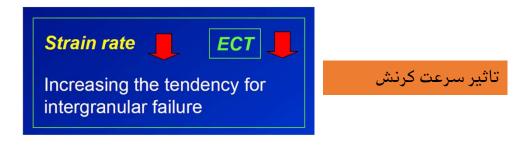
equicohesive temperature





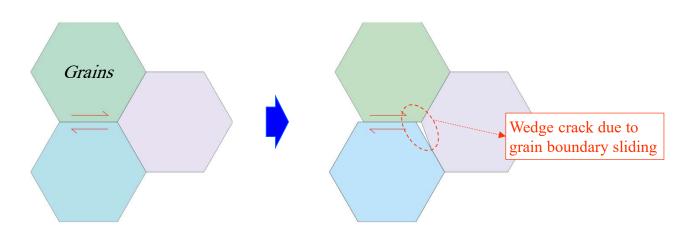






## Grain boundary sliding

- At low temperatures, the grain boundaries are '*stronger*' than the crystal interior and impede the motion of dislocations.
- Being a higher energy region, the grain boundaries *pre-melt* before the crystal interior.
- Above the *equicohesive* temperature, due to shear stress at the 'local scale', grain boundaries slide past one another to cause plastic deformation.
- The relative motion of grain boundaries can lead to wedge cracks at triple lines (junction of three grains). If these wedge cracks are not healed by diffusion (or slip), microstructural damage will accumulate, leading to specimen failure.



## Chapter 2

# Five-Power-Law Creep

 $0.5-0.6 T_{\rm m}$ 

### 2.1.1 Activation Energy and Stress Exponents

In pure metals and Class M alloys (similar creep behavior similar to pure metals), there is an established, largely phenomenological, relationship between the steady-state strain-rate,  $\dot{\epsilon}_{ss}$ , (or creep rate) and stress,  $\sigma_{ss}$ , for steady-state 5-power-law (PL) creep:

$$\dot{\varepsilon}_{ss} = A_0 \exp[-Q_c/kT](\sigma_{ss}/E)^n \tag{3}$$

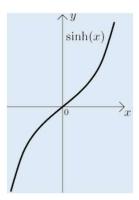
where  $A_0$  is a constant, k is Boltzmann's constant, and E is Young's modulus (although, as will be discussed subsequently, the shear modulus, G, can also be used). This is consistent with Norton's Law [34]. The activation energy for creep,  $Q_c$ , has been found to often be about that of lattice self-diffusion,  $Q_{sd}$ . The exponent n is constant and is about 5 over a relatively wide range of temperatures and strain-rates (hence "five-power-law" behavior)

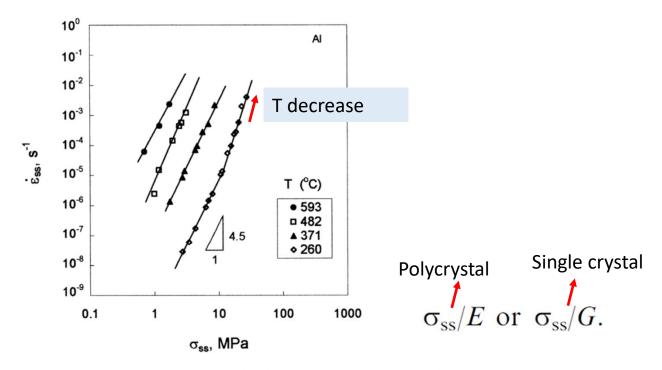
# power-law-breakdown (PLB) occurs, and n increases

the temperature decreases below roughly 0.5-0.6 Tm

#### Between this two laws:

$$\dot{\varepsilon}_{ss} = A_1 \exp[-Q_c/kT] [\sinh \alpha_1 (\sigma_{ss}/E)]^5$$





**Figure 7.** The steady-state stress versus strain-rate for high-purity aluminum at four temperatures, from Ref. [136].

The stress exponent is about 4.5 for aluminum. Although this is not precisely five, it is constant over a range of temperature, stress, and strain-rate, and falls within the range of 4–7 observed in pure metals and class M alloys

Modulus of rigidity or shear modulus 
$$G = \frac{E}{2(1+v)}$$

Modulus of elasticity or Young's modulus

Modulus of elasticity or Young's modulus

Modulus of elasticity or Young's modulus

 $G = \frac{E}{2(1+v)}$ 

Modulus of elasticity or Young's modulus

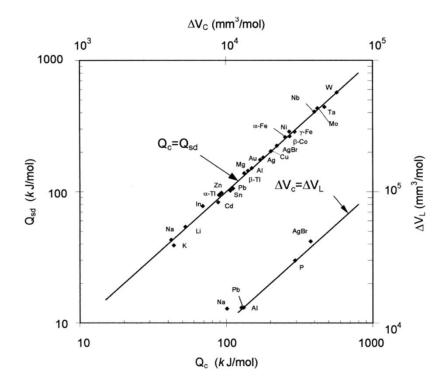
 $G = \frac{E}{2(1+v)}$ 

## Quick Summary

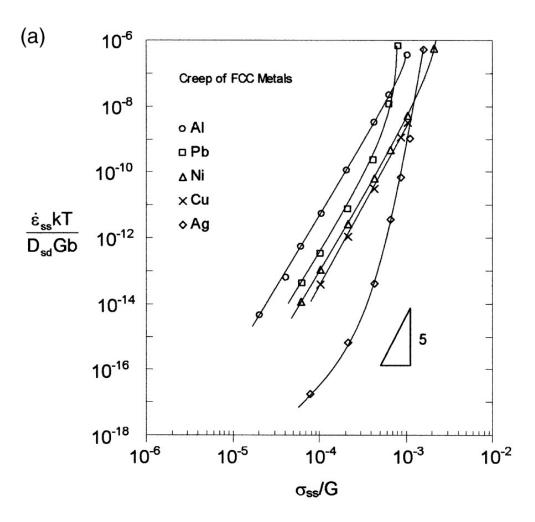
Property	Single Crystal	Polycrystal
Key deformation mode	Shear along slip systems	Overall tensile/compressive deformation
Dominant stiffness	Shear modulus (G)	Young's modulus (E)
Anisotropy	High	Averaged to isotropic

$$\dot{\varepsilon}_{ss} = A_2 \exp[-Q_{sd}/kT](\sigma_{ss})^{n(\approx 5)}$$

$$Q_{\rm c} = -\,\mathrm{k} \big[ \delta(\ln \dot{\varepsilon}_{\rm ss}) / \delta(1/T) \big]_{\sigma_{\rm ss}/E, \rm s}$$



**Figure 8.** The activation energy and volume for lattice self-diffusion versus the activation energy and volume for creep. Data from Ref. [26].



# Stacking Fault Energy

$$\dot{\varepsilon}_{ss} = A_6 (\chi/Gb)^3 (D_{sd}Gb/kT) (\sigma_{ss}/G)^5$$

where  $\chi$  is the stacking fault energy.

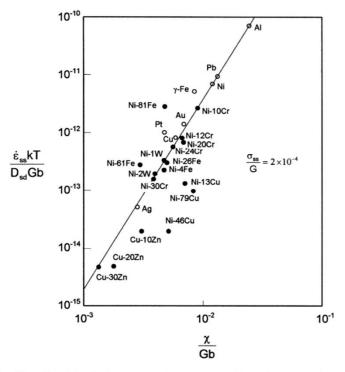


Figure 14. The effect of stacking fault energy on the (compensated) steady-state strain-rate for a variety of metals and Class M alloys based on Ref. [73].

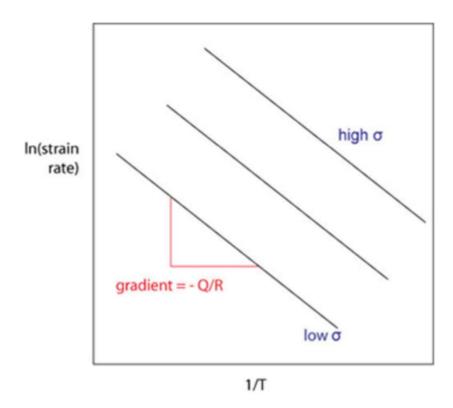
Lower SFE materials display wider stacking faults and have more difficulties for cross-slip.

The width of stacking fault is a consequence of the balance between the repulsive force between two partial dislocations

A stacking fault is created by the dissociation of a perfect dislocation into two partial dislocations.

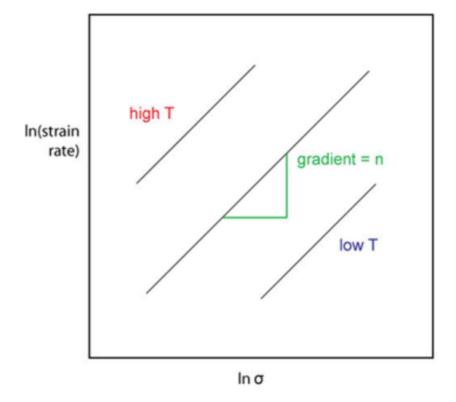
درصورتی که میزان انرژی نقض انباشتگی برای دو آلیاژ A و B به ترتیب ۱۰۰ و ۲۰۰ ارگ (erg) بر سانتی متر مربع باشد. کدامیک از آلیاژهای ذیل را در شرایط خزشی انتخاب می کنید؟ قانون خزشی برای این آلیاژها از کدام قانون پیروی می کند؟

$$\dot{\varepsilon}_{ss} = A_2 \exp[-Q_{sd}/kT](\sigma_{ss})^{n(\cong 5)}$$



The stress exponent n can be determined by plotting the strain rate as a function of stress.

$$\dot{\varepsilon}_{ss} = A_2 \exp[-Q_{sd}/kT](\sigma_{ss})^{n(\cong 5)}$$



The creeping coil experiment - variable stresses in a single specimen

$$\dot{\varepsilon}_{ss} = A_2 \exp[-Q_{sd}/kT](\sigma_{ss})^{n(\cong 5)}$$

$$Q_{c} = R \frac{\ln \left(\frac{\dot{\varepsilon}_{1}}{\dot{\varepsilon}_{2}}\right)}{\left(\frac{1}{T_{2}} - \frac{1}{T_{1}}\right)}$$

for the mechanisms causing creep.
We'll address the mechanisms shortly
(in great detail).

$$Q = R\left(\ln\frac{t_2}{t_1}\right)\left(\frac{T_1 \cdot T_2}{T_1 - T_2}\right)$$

**Example:** For the stress-minimum creep rate curve, determine the activation energy for creep at a stress of 100 MPa.

at 
$$T_2 = 700^{\circ} C = 973K$$
;  $\varepsilon_2 = 10^{-8} s^{-1}$   
at  $T_1 = 800^{\circ} C = 1073K$ ;  $\varepsilon_1 = 10^{-5} s^{-1}$ 

$$Q = \frac{R \ln(\varepsilon_1/\varepsilon_2)}{(1/T_2 - 1/T_1)} = \frac{(8.3 \text{Jmol}^{-1} \text{K}^{-1}) \ln(10^3)}{1/973 - 1/1073} = 599 \text{kJmol}^{-1}$$

## Chapter 5

# Three-Power-Law Viscous Glide Creep

Creep of solid solution alloys (designated Class I [16] or class A alloys [338]) at intermediate stresses and under certain combinations of materials parameters, which will be discussed later, can often be described by three regions [36,339,340]. This is illustrated in Figure 52. With increasing stress, the stress exponent, *n*, changes in value from 5 to 3 and again to 5 in regions I, II, and III, respectively. This section will focus on region II, the so-called Three-Power-Law regime.

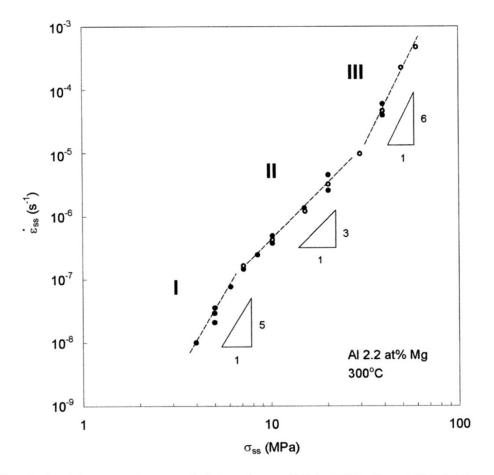
The mechanism of deformation in region II is viscous glide of dislocations [36]. This is due to the fact that the dislocations interact in several possible ways with the solute atoms, and their movement is impeded [343]. There are two competing mechanisms over this stress range, dislocation climb and glide, and glide is slower and thus rate controlling.

The **3-power law viscous glide creep** describes a creep mechanism where **dislocations move under the** influence of an external stress but are hindered by a viscous drag force.

Nickel-based superalloys are widely used in turbine blades for **jet engines and power plants** due to their high-temperature strength and creep resistance.

At moderate stress and high temperatures (600–900°C), 3-power law viscous glide creep is often observed before power-law creep (dislocation climb) dominates at even higher stresses.

Temperature: 0.4-0.6 Tm



**Figure 52.** steady-state creep rate vs. applied stress for an Al-2.2 at %Mg alloy at 300°C. Three different creep regimes, I, II, and III, are evident. Based on Refs. [341,342].

### Three-Power-Law mechanism

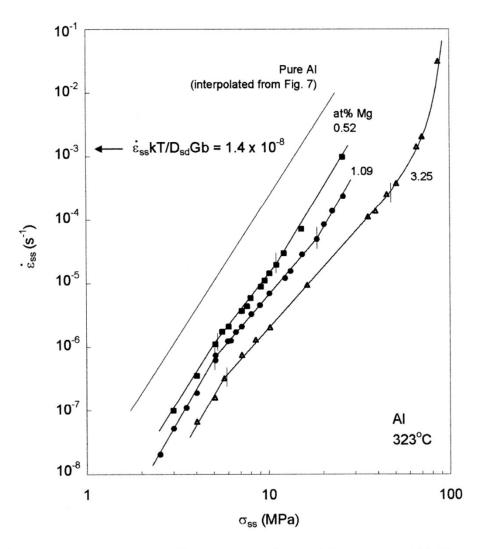
$$\dot{\epsilon} = 1/2 \, \bar{v} \, b \, \rho_{m}$$
 $\bar{v}$  is proportional to  $\sigma$ 
 $\rho_{m}$  is proportional to  $\sigma^{2}$ 

$$\dot{\mathbf{\epsilon}}_{\rm ss} \cong \frac{0.35}{\rm A} G \left(\frac{\rm o}{G}\right)^3$$

Cottrell–Jaswon eq.

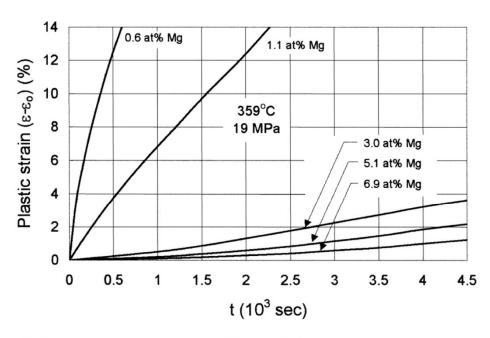
$$\dot{\varepsilon}_{ss} \cong \frac{\pi (1 - v) k T \tilde{D}}{6e^2 Cb^5 G} \left(\frac{\sigma}{G}\right)^3$$

where e is the solute-solvent size difference, C is the concentration of solute atoms and  $\tilde{D}$  is the diffusion coefficient for the solute atoms, calculated using Darken's analysis.

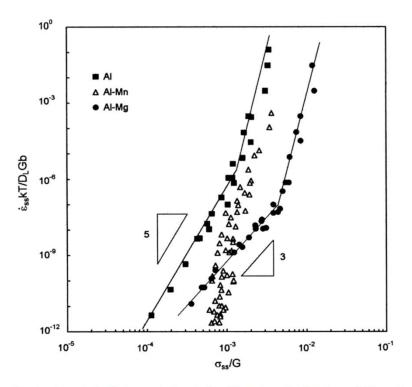


**Figure 53.** steady-state creep-rate vs. applied stress for three Al–Mg alloys (Al-0.52 at. %Mg,  $\nu$ ; Al-1.09 at. %Mg,  $\lambda$ Al-3.25 at. %Mg,  $\sigma$ ) at 323°C [356].

## Solute drag creep



**Figure 54.** Creep behavior of several aluminum alloys with different magnesium concentrations: 0.6 at.% and 1.1 at.% (class II (M)) and 3.0 at.%, 5.1 at.%, and 6.9 at.% (class I (A)). The tests were performed at 359°C and at a constant stress of 19 MPa [349].



Steady-state relation between strain-rate ἐ and flow stress for the alloys of this work compared
to literature data from slow tests (Al, Al–Mg, Al–Mn). Adapted from Ref. [556].

\_

### **Example Scenario**

Consider a **nickel-based superalloy** turbine blade operating at 800°C under a stress of 200 MPa. We want to estimate the **creep strain rate** ( $\dot{\varepsilon}$ ) using the 3-power law viscous glide creep equation:

$$\dot{\varepsilon} = A\sigma^3 \exp\left(\frac{-Q}{RT}\right)$$

- Stress (σ) = 200 MPa
- Temperature (T) = 800°C = 1073 K
- Activation Energy (Q) = 300 kJ/mol =  $3.0 \times 10^5$  J/mol
- Material Constant (A) =  $1.5 \times 10^{-25}$  (for the specific alloy)
- Gas Constant (R) = 8.314 J/(mol·K)

#### Step 1: Compute the Exponential Term

$$rac{Q}{RT} = rac{3.0 imes 10^5}{8.314 imes 1073} = rac{3.0 imes 10^5}{8920} pprox 33.6$$
  $\exp\left(-rac{Q}{RT}
ight) = e^{-33.6} pprox 2.54 imes 10^{-15}$ 

#### Step 2: Compute the Stress Term

$$\sigma^3 = (200 \times 10^6)^3 = 8 \times 10^{24}$$

#### Step 3: Compute the Creep Strain Rate

$$\dot{arepsilon} = (1.5 \times 10^{-25}) \times (8 \times 10^{24}) \times (2.54 \times 10^{-15})$$

$$= (1.2 \times 10^{0}) \times (2.54 \times 10^{-15})$$

$$\approx 3.05 \times 10^{-15} \text{ s}^{-1}$$

#### Interpretation of Results

- . This strain rate means that the material deforms extremely slowly under these conditions.
- Over a period of 10,000 hours (about 1 year and 2 months):

$$\Delta \varepsilon = \dot{\varepsilon} \times t = (3.05 \times 10^{-15}) \times (3.6 \times 10^7 \text{ s})$$
  
 $\approx 1.1 \times 10^{-7} \text{ (very small strain)}$ 

 This suggests that the material remains structurally stable for long operational times before significant creep damage occurs. Chapter 8

**Creep Behavior of Particle-Strengthened Alloys** 

## The creep behavior of second phase in the matrix:

- 1- Shape of precipitates
- 2- The coherency
- 3- Volume content
- 4- Particle size
- 5- Distribution of particles

It is well known that second-phase particles provide enhanced strength at lower temperatures

## Friedel cutting or Orowan by passing

Both Friedel cutting and Orowan bypassing describe how dislocations overcome obstacles in a material, playing a crucial role in dislocation motion, strengthening mechanisms, and creep behavior.

#### 1. Friedel Cutting

#### Definition

Friedel cutting refers to a mechanism where a dislocation cuts through weak obstacles (such as solute atoms or small precipitates) when a sufficiently high stress is applied. This allows the dislocation to continue gliding rather than being pinned.

#### **Key Aspects**

- · Occurs in materials with weak obstacles (soft precipitates, solute clouds).
- Dislocations shear through obstacles instead of looping around them.
- · More common at high temperatures when obstacle strength is reduced.
- · Leads to precipitate shearing, which is an important mechanism in alloys like Ni-based superalloys.

#### **Mathematical Condition**

For a dislocation to cut through an obstacle, the applied stress ( $\sigma$ ) must exceed a critical threshold:

$$\sigma > rac{Gb}{L}$$

where:

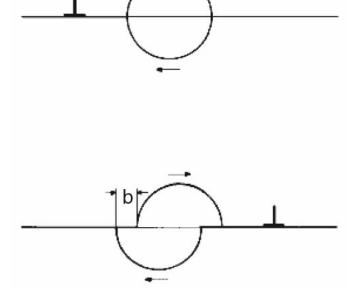
- G = shear modulus,
- b = Burgers vector,
- L = spacing between obstacles.

If the stress is not high enough to cut through, the dislocation may instead bypass via Orowan looping.

Friedel cutting: Dislocation is passing through particle and shifts its upper part with respect to the lower part. Extra surface energy has to be generated which limits this process to small particles.

Friedel cutting is possible for small and coherent particles only due to the extra surface energy which has to be raised when cutting the

particle.



#### 2. Orowan Bypassing

#### Definition

Orowan bypassing (or the Orowan mechanism) describes how a dislocation bypasses strong obstacles (such as hard precipitates) by looping around them, leaving behind dislocation loops.

#### **Key Aspects**

- · Occurs in materials with strong obstacles (e.g., hard precipitates in aluminum or nickel alloys).
- · Dislocations bow around the obstacle due to applied stress.
- · Forms a dislocation loop around the precipitate, increasing material strength.

#### **Mathematical Condition**

For a dislocation to bypass an obstacle, the applied stress ( $\sigma$ ) must be high enough to bend the dislocation into a loop:

$$\sigma > rac{Gb}{r}$$

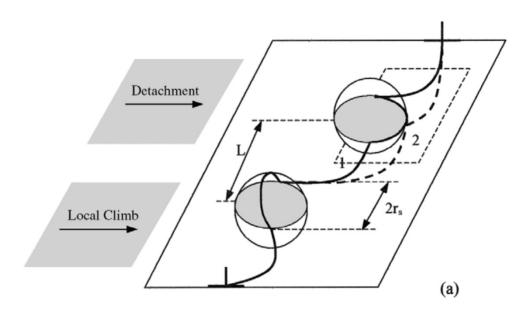
where:

r = obstacle radius (smaller obstacles require higher stress).

Since the bypassed obstacle remains intact, the Orowan mechanism leads to precipitation strengthening and is key in high-strength materials.

## Orowan by passing

The Orowan stress is determined by the bypass stress based on an Orowan loop mechanism Strengthening from coherent particles can occur in a variety of ways that usually involve particle cutting.



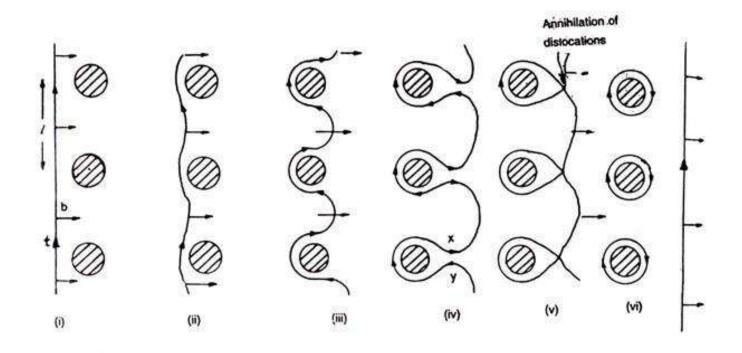


Fig. 13.10. Interaction of a dislocation with a row of widely spaced precipitates to bypass them

وقتی که ذرات رسوبی و زمینه دارای شبکه کریستالی مشابه باشد – بهطور مثال دارای اختلاف پارامتر شبکه در حدود ۲/۰ درصد – در این حالت رسوب با زمینه هم سیما بوده و نابجاییها میتوانند از روی سطح رسوب عبور کنند.

اما اگر رسوب با زمینه هم سیما نباشد در این صورت رفتار نابجایی با رسوب دو حالت دارد. اگر اندازه ذرات کوچک باشد نابجایی به صورت برش و اگر بزرگ باشد نابجایی رسوب را دور میزند.

زمانی که رسوب درشت باشد امکان برش آنها با انرژی بیشتری رخ میدهد که کمتر اتفاق میافتد و نابجایی سعی می کند با دور زدن و تشکیل حلقههای اروان از ذره عبور کند.

## Friedel Cutting vs. Orowan Bypassing

Mechanism	Obstacle Strength	Outcome
Friedel Cutting	Weak obstacles (shearable)	Dislocation cuts through, no loops
Orowan Bypassing	Strong obstacles (non-shearable)	Dislocation loops around

## **Real-World Examples**

- Friedel cutting: In Ni-based superalloys, small γ' precipitates can be sheared by dislocations at high temperatures.
- Orowan bypassing: In Al-Mg alloys, strong second-phase particles cause dislocations to bow and form loops, strengthening the material.

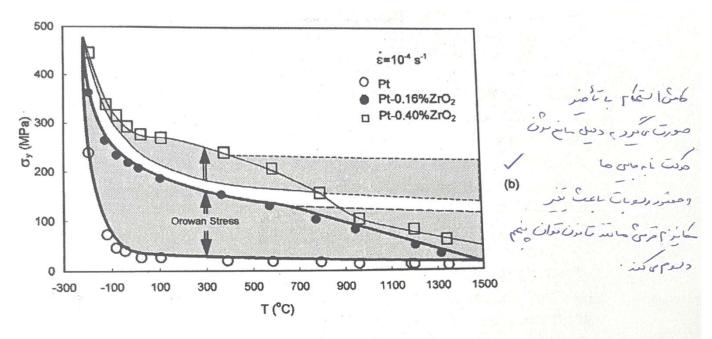
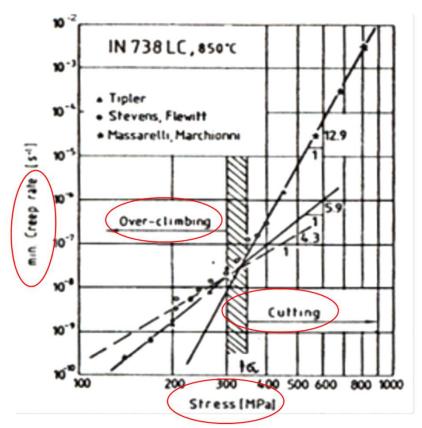
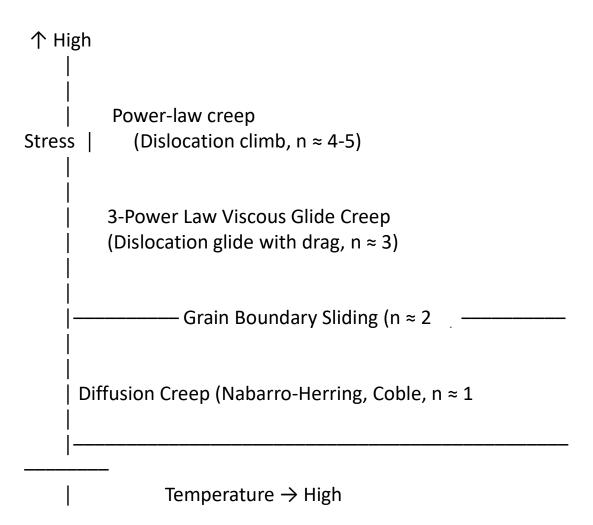


Figure 68. Compressive 0.2% yield stress versus temperature. Shaded: Orowan stress given as low-temperature yield-stress increment due to oxide dispersoids. (a) ODS Superalloy MA 754, (b) Pt-based ODS alloys. From Ref. [544].



تصویر ۱۷. تغییر مکانیزم خزشی در تنش ۳۰۰ aPM با توجه به تغییرات تنش در دمای °C ۸۵۰ برای سوپرآلیاژ ۱۸۷۲ [۳۱].

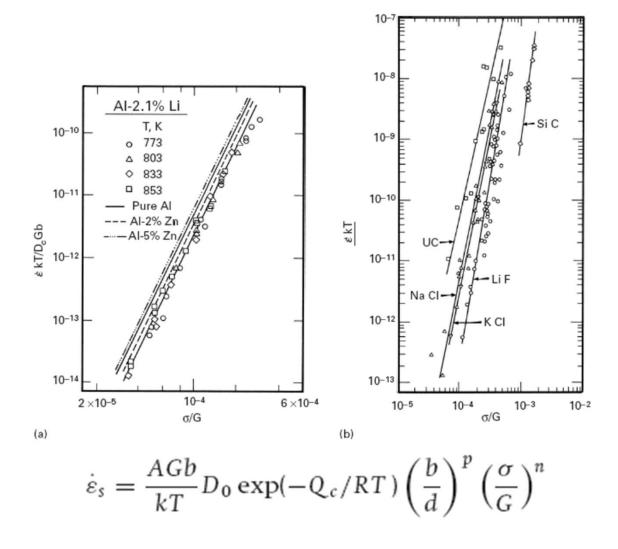
Creep Mechanism	Dominant Process	Stress Exponent ( n)	Temperature Dependence	Typical Conditions
Diffusion Creep (Nabarro-Herring, Coble)	Atom diffusion through lattice (NH) or grain boundaries (C)	1.	High (Arrhenius-type)	Low stresses, high temperatures
Dislocation Climb Creep (Power-Law Creep)	Climb-controlled dislocation motion	4-5	High	Moderate to high stresses & temperatures
3-Power Law Viscous Glide Creep	Dislocations moving under viscous drag	3	Moderate	Intermediate stresses & temperatures
Grain Boundary Sliding	Grain boundary shear accommodating creep	1-2	Moderate	Fine-grained materials, moderate temperatures



	Mechanism	D	n	A	
	Climb of edge dislocations	$\mathrm{D}_{\mathrm{L}}$	5	$6x10^{7}$	
	(Pure Metals and class-M alloys)	(n function of	f Xal struct	ure & Γ)*	
PLB	Low-temperature climb	$\mathrm{D}_{\perp}$	7	$2x10^{8}$	
Viso	cous glide (Class-I alloys - microcreep)	$D_s$	3	6	
_	Nabarro-Herring	$D_L$	1	$14(\frac{b}{d})^2$	
	Coble	$D_b$	1	$100 \left(\frac{b}{d}\right)^3$	
	Harper-Dorn	$\mathrm{D}_{\mathrm{L}}$	1	3x10 <sup>-10</sup>	
_	GBS (superplasticity)	D <sub>b</sub>	2	$200 \left(\frac{b}{d}\right)^2$	
*	$D_L$ = lattice diffusivity; $D_s$ = solute diffusivity; $D_\perp$ = core diffusivity;				
	$D_b$ = Grain-Boundary Diffusivity; $b$ = Burgers vector; $d$ = grain size;				
	$\delta = \text{subgrain size} = 10 \frac{\text{Gb}}{\tau}$ and $\rho = \frac{\sigma^2}{\text{G}^2\text{b}^2}$ where G is the shear modulus				

<sup>\*</sup>n increases with decreasing  $\Gamma$  (stacking-fault energy)

# Mukherjee-Bird-Dorn Equation



## General equation

$$rac{\mathrm{d}arepsilon}{\mathrm{d}t} = rac{C\sigma^m}{d^b}e^{rac{-Q}{kT}}$$

where  $\varepsilon$  is the creep strain, C is a constant dependent on the material and the particular creep mechanism, m and b are exponents dependent on the creep mechanism, Q is the activation energy of the creep mechanism,  $\sigma$  is the applied stress, d is the grain size of the material, k is Boltzmann's constant, and T is the absolute temperature. [6]

Most often several creep mechanisms operate simultaneously. If more than one mechanism operates independently of each other, i.e. they operate parallelly, then the total steady-state creep rate is given by

$$\dot{\varepsilon}_{\rm s} = \sum \dot{\varepsilon}_i \tag{7.43}$$

where  $\dot{\varepsilon}_i$  is the creep rate for *i*th mechanism. For *parallel* mechanisms, the fastest one will control or dominate the creep deformation. If there are *i* number of mechanisms that operate sequentially, i.e. operate in series, then the total steady-state creep rate is given by

$$\epsilon$$
 total=  $\epsilon$  1+  $\epsilon$  2+  $\epsilon$ 3

$$\frac{1}{\dot{\varepsilon}_{\rm s}} = \sum_{i} \frac{1}{\dot{\varepsilon}_{i}} \tag{7.44}$$

For *series mechanisms*, the slowest one will control or dominate the creep deformation.

 Many different mechanisms may contribute and the total strain-rate : parallel mechanism
 series mechanisms

(fastest controls / dominates)

$$\dot{\mathcal{E}} = \sum_{i} \dot{\mathcal{E}}_{i}$$

(slower controls / dominates)  $\dot{\varepsilon} = \sum \left(\frac{1}{\dot{\varepsilon}_i}\right)^{-1}$ 

$$\mathcal{E}_{t} = \sum_{i=1}^{n} \frac{1}{\dot{\epsilon}_{i}}$$

$$\dot{\epsilon}_{t} = \frac{\varepsilon}{t} + \frac{\varepsilon}{\dot{\epsilon}_{i}}$$

$$\dot{\epsilon}_{t} = \frac{\varepsilon}{t} + \frac{\varepsilon}{\dot{\epsilon}_{i}}$$

$$\dot{\epsilon}_{t} = \frac{\varepsilon}{\dot{\epsilon}_{i}} + \frac{\varepsilon}{\dot{\epsilon}_{i}}$$

$$\dot{\epsilon}_{t} = \frac{\varepsilon}{\dot{\epsilon}_{i}} + \frac{\varepsilon}{\dot{\epsilon}_{i}}$$

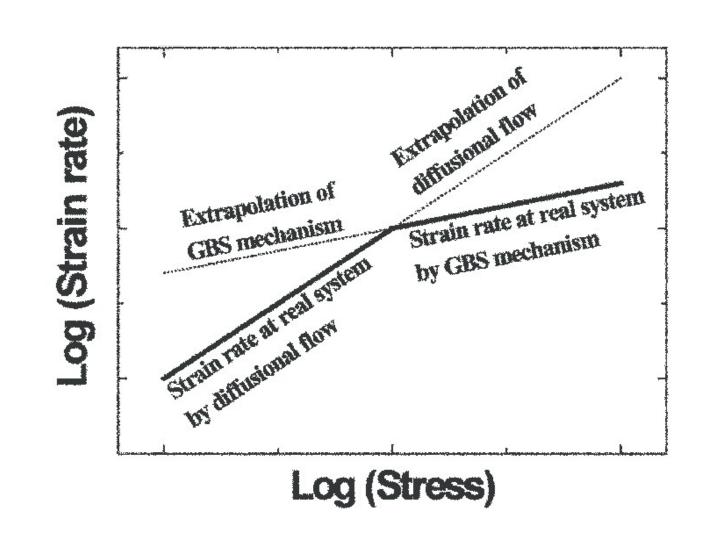
$$\dot{\epsilon}_{t} = \frac{\varepsilon}{\dot{\epsilon}_{i}} + \frac{\varepsilon}{\dot{\epsilon}_{i}}$$

$$\dot{\epsilon}_{t} = \sum_{i=1}^{n} \dot{\epsilon}_{i}$$

$$\dot{\epsilon}_{t} = \sum_{i=1}^{n} \dot{\epsilon}_{i}$$

$$\dot{\epsilon}_{t} = \dot{\epsilon}_{i} + \dot{\epsilon}_{i}$$

$$\dot{\epsilon}_{t} = \dot{\epsilon}_{i}$$



$$\dot{e} = \frac{de}{dt} = \frac{d\left(\frac{L-L\cdot}{L\cdot}\right)}{dt} = \frac{1}{L\cdot} \frac{dL}{dt} = \frac{V}{L\cdot}$$

$$\dot{\epsilon} \cdot \frac{d\epsilon}{dt} = \frac{d\left(\ln\frac{L}{L\cdot}\right)}{dt} = \frac{1}{L\cdot} \frac{dL}{dt} \cdot \frac{V}{L\cdot}$$

$$\dot{\epsilon} \cdot \frac{d\epsilon}{dt} = \frac{d\left(\ln\frac{L}{L\cdot}\right)}{dt} = \frac{1}{L\cdot} \frac{dL}{dt} \cdot \frac{V}{L\cdot}$$

$$\dot{\epsilon} \cdot \frac{V}{L} = \frac{\dot{\epsilon}L\cdot}{L\cdot} = \frac{\dot{\epsilon}}{1+\epsilon}$$

$$\dot{\epsilon} \cdot \frac{\dot{\epsilon}}{1+\epsilon}$$

$$\dot{\epsilon} \cdot \frac{\dot{\epsilon}}{1+\epsilon}$$

سرعت فک دستگاه خزشی را بر حسب پارامتر سرعت خزش و طول اولیه بیابید؟

$$v = \varepsilon l = \varepsilon (l \cdot (i + e)) = \varepsilon l \cdot (i + e)$$

$$\varepsilon = \ln(i + e) \rightarrow (i + e) = \exp(\varepsilon)$$

$$v = \varepsilon l \cdot \exp(\varepsilon)$$

$$\dot{\varepsilon} = \dot{\varepsilon}$$

$$v = \varepsilon l \cdot \exp(\varepsilon)$$

## Chapter 10

# **Creep Fracture**

#### 10.1 BACKGROUND

Creep plasticity can lead to tertiary or Stage III creep and failure. It has been suggested that Creep Fracture can occur by w or Wedge-type cracking, illustrated in Figure 101(a), at grain-boundary triple points. Some have suggested that w-type cracks form most easily at higher stresses (lower temperatures) and larger grain sizes [786] when grain-boundary sliding is not accommodated. Some have suggested that the Wedge-type cracks nucleate as a consequence of grain-boundary sliding. Another mode of fracture has been associated with r-type irregularities or cavities illustrated in Figure 102. The Wedges may be brittle in origin or simply an accumulation of r-type voids [Figure 101(b)] [787]. These Wedge cracks may propagate only by r-type void formation [788,789]. Inasmuch as w-type cracks are related to r-type voids, it is sensible to devote this short summary of Creep Fracture to cavitation.

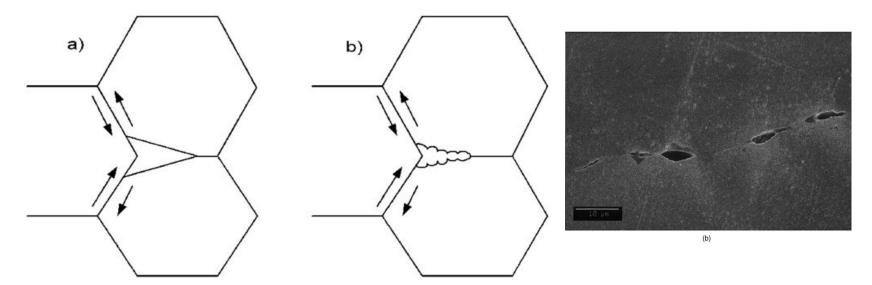
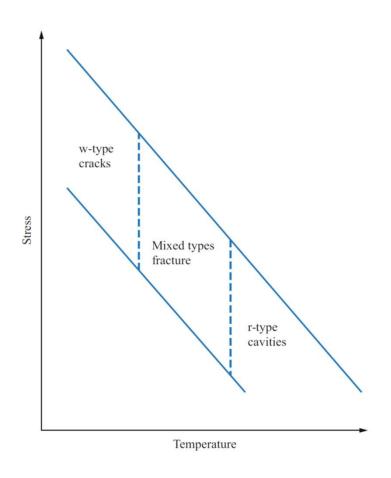
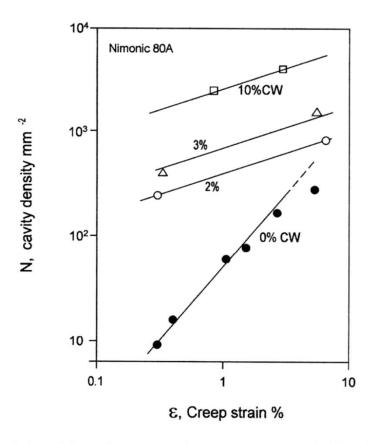


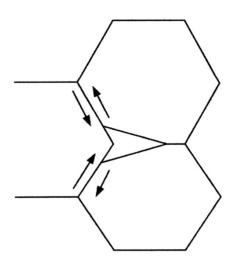
Fig. 2. (a) Wedge (or w-type) crack formed at the triple junctions in association with grain boundary sliding; (b) illustrates a wedge crack as an accumulation of spherical cavities.



عوامل موثر بر نوع شکست ۱- دما ۲- تنش ۳- کار سرد (مرزدانه های سه تایی) ٤- تبلور مجدد



**Figure 106.** The variation of the cavity concentration versus creep strain in Nimonic 80A (Ni–Cr alloy with Ti and Al) for annealed and pre-strained (cold-worked) alloy. Adapted from Dyson [611]. Cavities were suggested to undergo unconstrained growth.



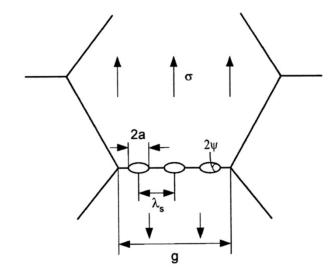
#### w or Wedge-type cracking

$$\sigma r_0 = 2\gamma_{\rm s}, \quad {
m or}, \quad \sigma = \frac{2\gamma_{\rm s}}{r_0}$$

where

- $\gamma_s$  the surface energy per unit area, and
- $r_0$  the interatomic distance

$$au_c pprox \sqrt{rac{\gamma G}{d}}$$



## Cavitation (r-type) or voids

$$\sigma_{
m max} = \sqrt{rac{L}{2
ho_{
m t}}} \cdot au \quad {
m for} \ L \gg 
ho_{
m t}$$

where

- τ shear stress along grain boundary, say mn,
- L length of the sliding boundary and
- $\rho_{\rm t}$  radius of curvature at the tip of the boundary

$$au_cpprox\sqrt{rac{\gamma E}{d}}$$

with 
$$T = \frac{8cb}{8(1-1)L}$$

with  $T = \frac{8cb}{8(1-1)L}$ 
 $T = \frac{\pi}{2} \left(\frac{2a}{\lambda s}\right) \left(\frac{2bc}{11-4}\right)d$ 

where  $\frac{\pi}{2}$  is  $\frac{\pi}{2}$ .

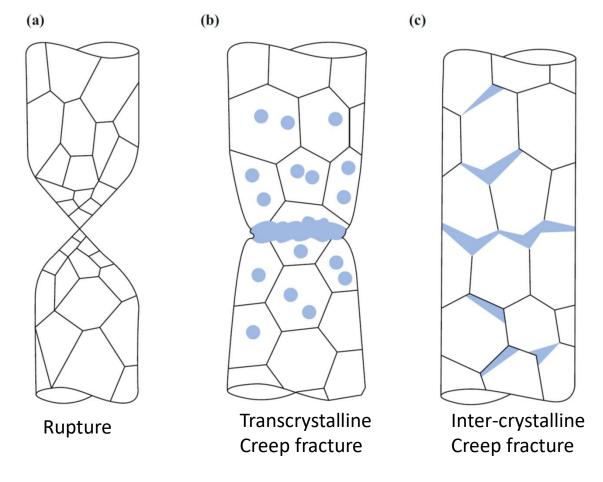
Feature	W-type Cracking	R-type Voids	
Micromechanism	Grain boundary sliding → cavity opening into a wedge	Diffusion of vacancies → void nucleation and growth	
Growth behavior	Crack-like propagation	Cavity growth + linking over time	
Creep regime	Often in tertiary creep (accelerated deformation)	Begins in <b>secondary creep</b> , accelerates later	
Fracture behavior	Brittle-like intergranular fracture	Ductile rupture with intergranular features	
Mitigation	Grain boundary strengthening, control of precipitates	Control of purity, reduce triaxial stresses, diffusion barriers	
Criticality	Often catastrophic (sharp cracks)	More gradual, but can still lead to fracture via linking	

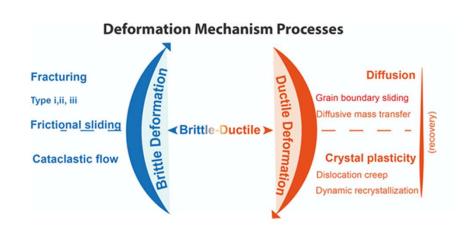
## In Practice: Often Coexist

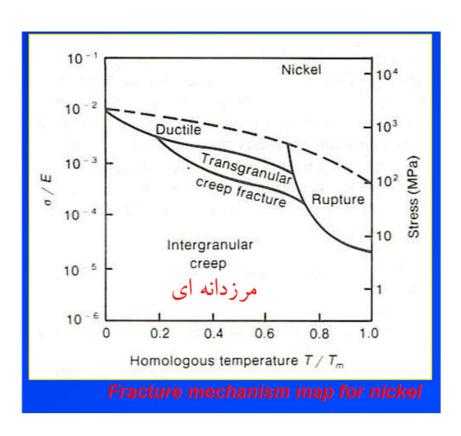
In real components under long-term creep (turbines, boilers, reactors), R-type voids often form first, and with continued stress and grain boundary sliding, W-type cracks initiate and propagate, causing final fracture.

## Modes of high-temperature failure

Fig. 7.22 Three modes of high temperature failure: a rupture; b transcrystalline creep fracture, in which the coloured circles represent intragranular voids that form, grow and coalescence leading to failure; c intercrystalline creep fracture, in which the coloured shaded regions at grain boundaries are intercrystalline voids or cracks that nucleate, grow and coalescence to some degree followed by fracture (Courtney 1990)



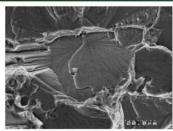




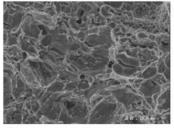
# Fracture at elevated temperature

## Transgranular fracture

Slip planes are weaker than grain boundaries



Transgranular cleavage fracture

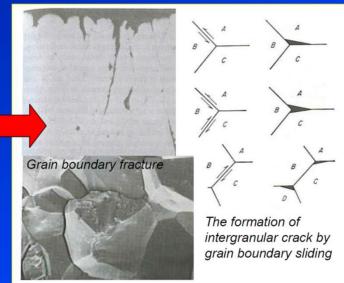


Transgranular microvoid coalescence

## Temp

Intergranular fracture

Grain boundaries are weaker than slip planes.



Note: at T just below  $T_{recrys}$ , ductility drops due to grain boundary sliding  $\rightarrow$  intergranular failure.

#### **Ductile fracture:**

Ductile fracture is characterized by extensive plastic deformation and absorbs significant energy before fracture. A crack, formed as a result of the ductile fracture, propagates slowly and when the stress is increased.

#### **Brittle fracture:**

**Brittle fracture** is characterized by very low plastic deformation and low energy absorption prior to breaking. A crack, formed as a result of the brittle fracture, propagates fast and without increase of the stress applied to the material.

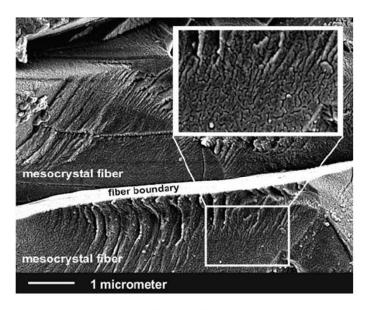
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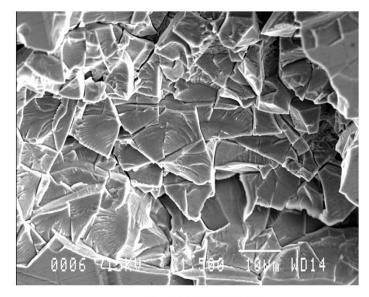
Generally fracture can be divided into 2 types such

- Brittle fracture (eg. Cast iron)
- Ductile fracture (eg. Mild steel)

Further it can e classified,

Depends on the appearance as 1.shearing fracture and 2.cleavage fracture and crystallographic nature as 1. fibrous and 2.granular fracture





Fibrous fracture

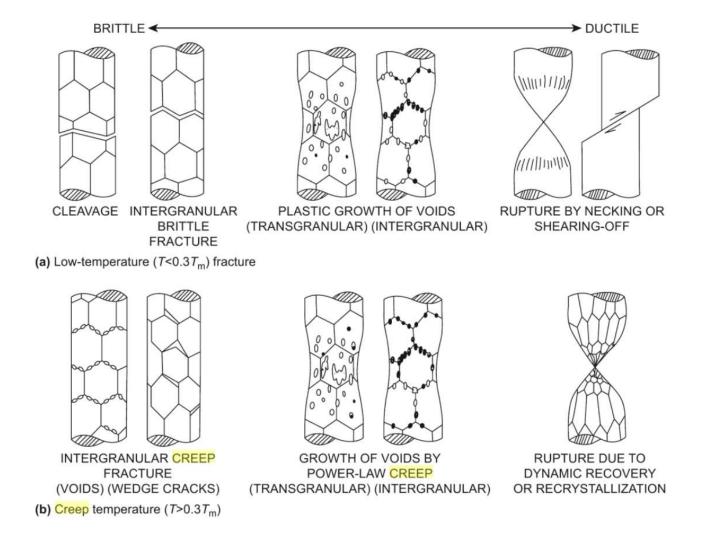
<u>cleavage</u> fracture

## Define cleavage fracture.

In brittle crystalline materials, fracture can occur by *cleavage* as the result of tensile stress acting normal to crystallographic planes with low bonding (cleavage planes). After the formation of micro crack described above, if the crack propagates along a weak crystallographic plane it is known as cleavage fracture.

#### 7. Distinguish between ductile fracture and brittle fracture?

Ductile fracture	Brittle fracture		
Materials fractures after plastic deformation and slow propagation of crack.  Fractured surfaces are dull or fibrous in appearance.	Materials fractures with very little or no plastic deformation, e.g. in a china clay, glass etc  Fractured surfaces are crystalline in appearance		
Percentage elongation is about 30% prior to fracture occurs.	Percentage elongation is about 0.5% or almost nil prior to fracture occurs.		
There is reduction in cross-sectional area of the specimen.	There is virtually no change in the cross sectional area.		
Fracture takes place after necking with little sound.	Fracture occurs rapidly often accompanied by a Loud noise.		



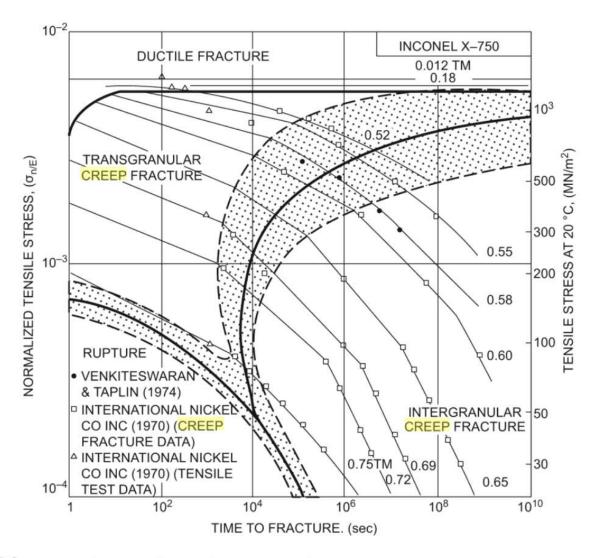


Fig. 2.3 Fracture mechanism map for Inconel X-750. Source: Ref 2.1

## تفاوت و شباهت حالت های rupture و

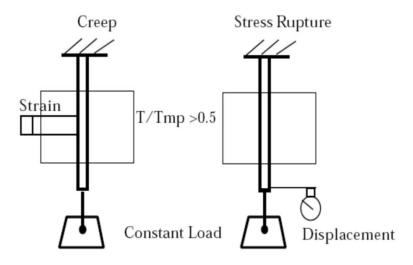
rupture -۱ در دماهای بالا و تنش پایین تر از حالت ductile اتفاق می افتد.

۲- در rupture بازیابی دینامیکی داریم در صورتی که در ductile اتفاق نمی افتد.

۱ - هر دو می توانند پدیده necking را تجربه کنند.

۲- هر دو می توانند جز شکست نرم محسوب شوند.

# Creep vs. Stress Rupture Test



- Low Loads
- Precision Strain Measurement (εf<0.5%)
- Expensive equipment

Emphasis on minimum strain rate at stress and temperature

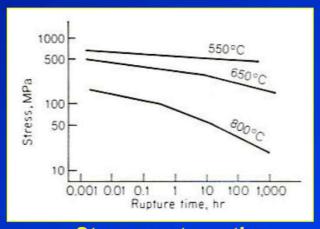
- High Loads
- Gross Strain Measurement (Ef up to 50%)
- Long term (2000-10,000 h) Short term (<1000 h)
  - Less expensive equipment

Emphasis on time to failure at at stress and temperature

## Stress Rupture Tests

- Determines the time necessary for material to result in failure under a overload.
- Useful in materials selection where dimensional tolerances are acceptable, but rupture cannot be tolerated.
- Generally performed at elevated temperatures.
- Smooth, notched, flat specimens or samples of any combination can be tested.

The *rupture test* in carried out in a similar manner to the *creep test* but at a *higher stress level* until the specimen fails and the *time at failure* is measured.



Stress rupture- time data on log-log scale

- Rupture strength and failure time are plotted, normally showing a straight line.
- Changing of the slope indicates structural changes in the material, i.e., transgranular → intergranular fracture, oxidation, recrystallisation, grain growth, spheroidization, precipitation.
- Direct application in design.

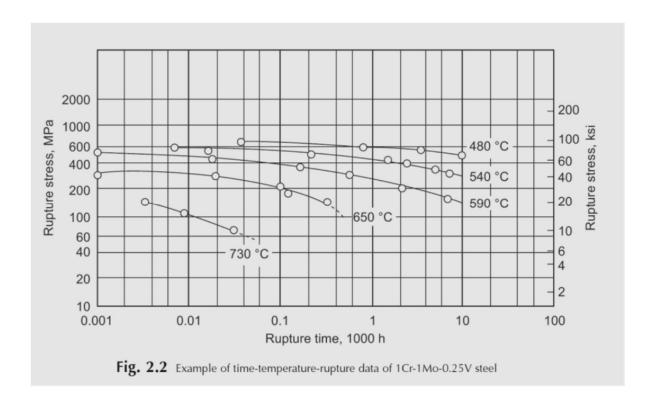
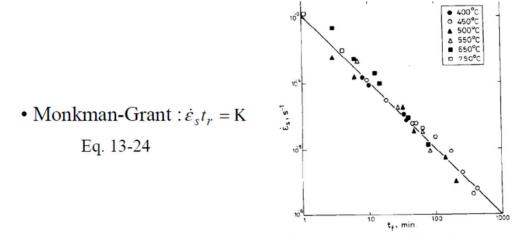


Table 2.1 Some stress-rupture time-temperature parameters developed in the 1950s

Authors' names and year	Reference	Form of parameter		
Larson and Miller (1952)	Ref 2.3	$T(C_{LM} + \log t)$		
Manson and Haferd (1952)	Ref 2.5	$(\log t - \log t_a)/(T - T_a)$		
Manson and Brown (1953)	Ref 2.8	$(\log t - \log t_a)/(T - T_a)$		
Orr et al. (1954)	Ref 2.6	$\log t - \Delta H/RT$		
Manson and Succop (1956)	Ref 2.9	$(\log t + C_{MS}T)$		



Demonstration of Monkman-Grant Relationship in Cu (Feltham and Meakin 1959)

Monkman-Grant relationship predicts time of failure due to creep mechanisms. Monkman-Grant relationship relates minimum strain rate and time to failure

$$\dot{\epsilon}_{min} t_f = C \approx \epsilon_f$$

$$\varepsilon^{\cdot} = \frac{d\varepsilon}{dt} = Aexp\left(-\frac{Q}{RT}\right)\sigma^{n} = A^{*}$$

 $\varepsilon$   $dt=A^*$  $\varepsilon$  t=MGP Modified Monkman-Grant relation (MMGR)

$$\dot{\varepsilon}_{\rm m} \cdot \frac{{\rm t_{\rm r}}}{\varepsilon_{\rm f}} = constant = C_{MMG}.$$

where  $\varepsilon_f$  is the strain to failure

• Larson-Miller Parameter : 
$$P_{L-M} = T (log t + C)$$

• Sherby-Dorn Parameter : 
$$P_{S-D} = t e^{-Q/RT}$$

• Manson-Haferd Parameter : 
$$P_{M-H} = \frac{T - T_a}{\log t - \log t_a}$$

# **Material Parameters**

Material			Manson–Haferd	
	Sherby–Dorn Q, kJ/mol	Larson–Miller C	$T_{a'}$ , K	$\log t_a$
Various steels and stainless steels	≈400	≈20	_	_
Pure aluminum and dilute alloys	≈150	_	-	_
S-590 alloy (Fe base)	350	17	172	20
A-286 stainless steel	380	20	367	16
Nimonic 81A (Ni base)	380	18	311	16
1% Cr-1% Mo-0.25%V steel	460	22	311	18

## Larson Miller Parameter

Model based on Arrhenius rate equation.

```
LMP= T(C+log t<sub>r</sub>)
Where T = temperature (K<sub>r</sub>)
t<sub>r</sub> = time before failure (hours)
C= material specific constant
```

- Predicts rupture lives given certain temperature and stress.
- First used by General Electric in the 50's to perform research on turbine blades.

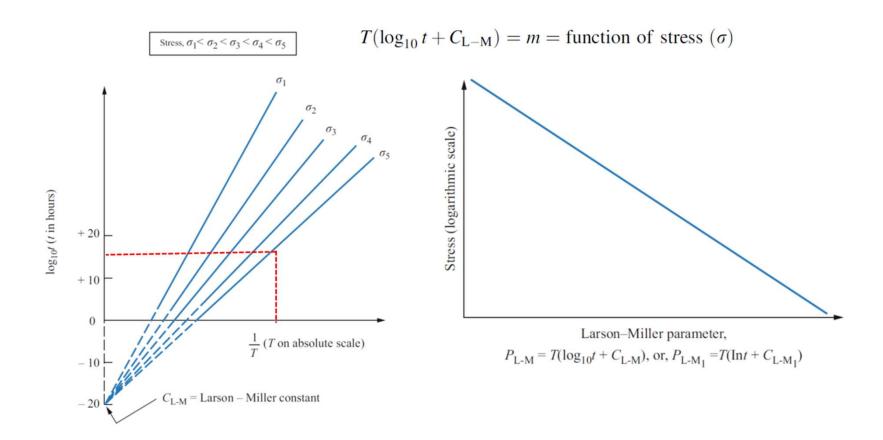
## $d\epsilon/dt = A \exp(-Q/RT)$

$$\int_{0}^{\varepsilon} d\varepsilon = A_{1} e^{-Q/RT} \int_{0}^{t} dt$$

$$\therefore t = \frac{\varepsilon}{A_{1}} e^{Q/RT} = \theta e^{Q/RT}$$

$$\log_{10} t + C_{L-M} = m \left(\frac{1}{T}\right)$$

$$T(\log_{10} t + C_{L-M}) = m = \text{function of stress } (\sigma)$$



#### 3) Hertzberg, 5.8

If the Larson-Miller parameter for a given elevated temperature alloy was found to be 26,000, by how much would the rupture life of a sample be estimated to decrease if the absolute temperature of the test were increased from 1100 to 1250K? Assume that the Larson-Miller constant is equal to 20.

Solution: LMP=  $T(C+log t_r)$ 

1100K:

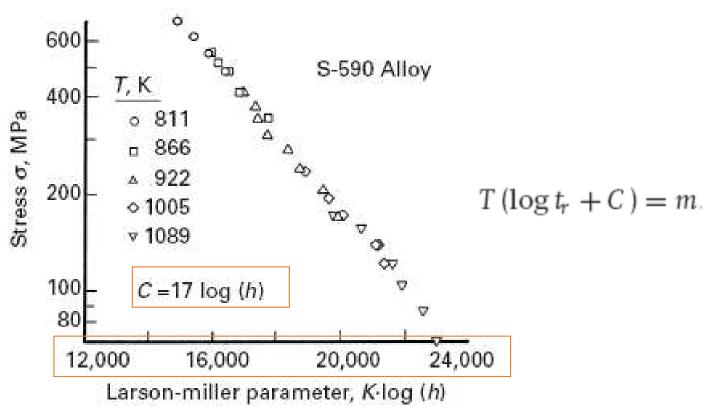
$$26000 = 1100(20 + \log t_1)$$
  
$$t_1 = 4329hr$$

1250K:

$$26000 = 1250(20 + \log t_2)$$
  
$$t_2 = 6.3hr$$

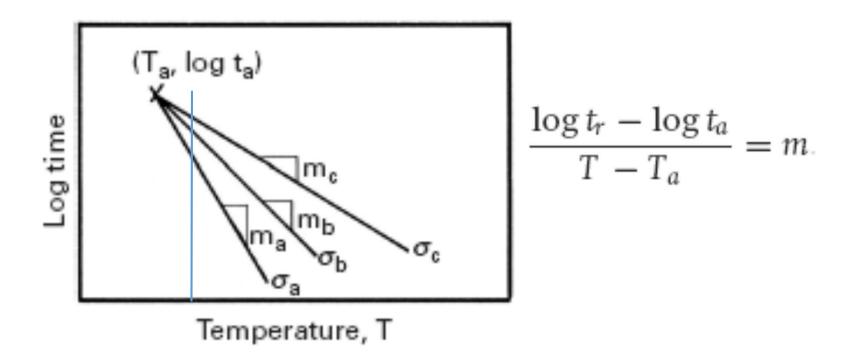
The rupture life will decrease from 4329hr to 6.3 hr.

## Larson-Miller Parameter



Master plot for Larson–Miller parameter for S-590 alloy (an Fe-based alloy) (C = 17).

## Manson-Hafered Parameter

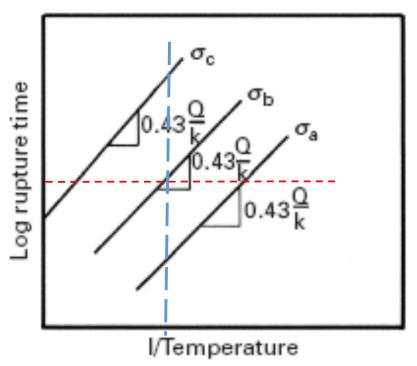


Relationship between time rupture and temperature at three levels of stress,  $\sigma a$ ,  $\sigma b$ , and  $\sigma c$ , using Manson–Haferd parameter ( $\sigma a > \sigma b > \sigma c$ ).

# **Sherby-Dorn Parameter**

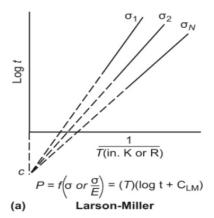
• Sherby-Dorn Parameter:

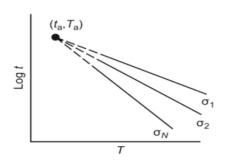
$$P_{S-D} = t e^{-Q/RT}$$



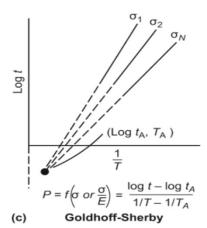
$$\log t_r - m = 0.43 \frac{Q_c}{kT}$$

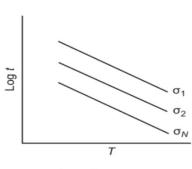
Relationship between time to rupture and temperature at three levels of stress,  $\sigma a > \sigma b > \sigma c$ , using Sherby–Dorn parameter.

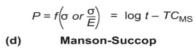


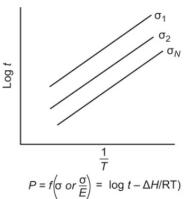


$$P = f\left(\sigma \ or \frac{\sigma}{E}\right) = \frac{\log t - \log t_a}{T - T_a}$$
 (b) Manson-Haferd









(e) Orr-Sherby-Dorn

#### Example:

Calculate the time to rupture at 650°C and 100MPa stress for a 1%Cr-1% Mo-0.25%V steel, according to the Larson-Miller, Sherby--Dorn, and Manson--Haferd methods, if this alloy underwent rupture in 20hrs when tested in tension at the same stress level at a temperature of 750°C.

#### Solution:

```
The Larson-Miller equation is T(\log t_r + C) = m.
At 750°C, T = 750 + 273 = 1,023^0 K and t_r = 20 hours. Therefore, m = 1023 \times (\log 20 + 22) \approx 2.4 \times 10^4
At 650°C, T = 650 + 273 = 923^0K, and we have 923(\log t_r + 22) = 2.4 \times 10^4, so that \log t_r = (2.4 \times 10^4/923) - 22
\mathbf{t_r} = \mathbf{6.7} \times \mathbf{10^3} hours.
```

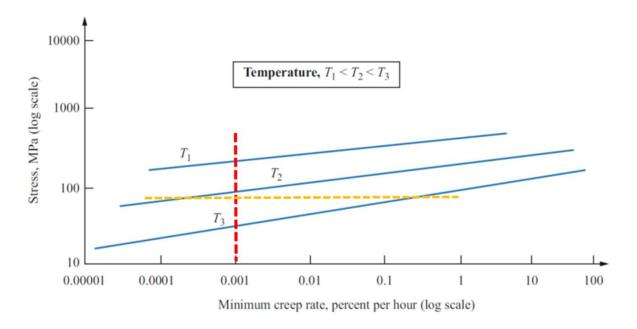
The Sherby-Dorn equation is  $\log t_r - Q/(kT) = m$ . From Table 1, Q = 460 kJ/mol. Because Q here involves moles, we must use R instead of k. At  $750^{\circ}$ C,  $T = 1,023^{0}$  K and  $t_r = 20$  hours. Thus,  $m = \log 20 - (460 \times 10^3/8.314 \times 1023)$  At  $650^{\circ}$ C,  $T = 923^{0}$  K, and we obtain  $\log t_r = m + 0.43(Q/kT)$  so that  $t_r = 6 \times 10^3$  hours.

```
The Manson-Haferd equation is (\log t_r - \log t_a)/(T - T_a) = m. From Table 1, Ta = 311 K, and \log t_a = 18. At 750^{\circ}C, T = 1,023^{0} K, and it follows that t_r = 20 hours. Therefore, m = (\log 20 - 18)/(1,023 - 311) = -0.023. At 650^{\circ}C, T = 923^{0} K, and we have (\log t_r - \log t_a)/(T - T_a) = m (\log t_r - 18)/(923 - 311) = -0.023, \log t_r = 3.924,
```

 $t_r = 8.4 \times 103 \text{ hours.}$ 

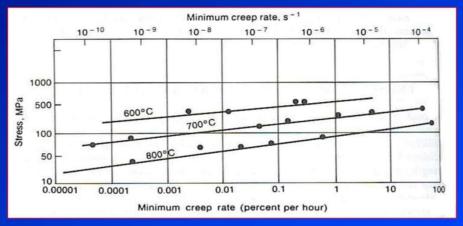
# **Prediction of Creep Strength**

Fig. 7.30 Variation of minimum creep rate with stress at various temperatures for a given material (schematic)



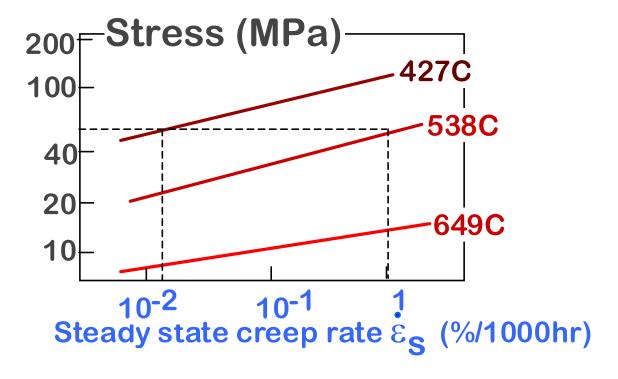
# Presentation of engineering creep data

Creep strength is defined as the stress at a given temperature, which produces a steady-state creep rate (10-11 to 10-8 s-1.)



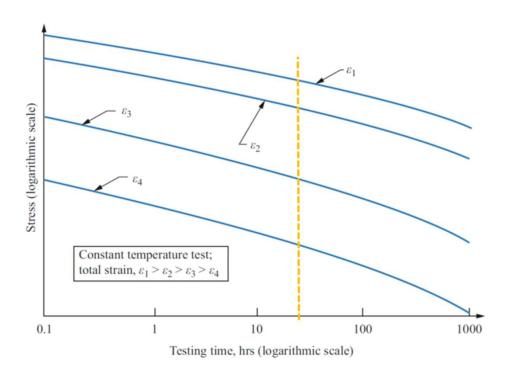
Stress vs minimum creep rate

• Log-log plot is used so that the extrapolation of one log-cycle represents a *tenfold change*.



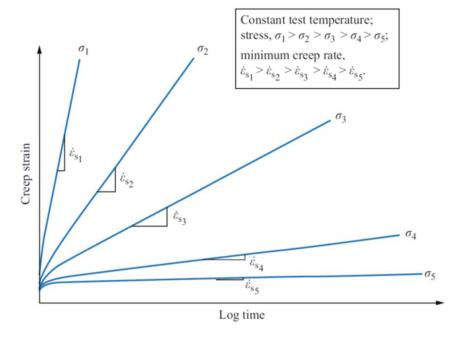
## **Prediction of Creep Strength**

Fig. 7.28 Stress versus testing time on log-log plot for different amounts of total strain for a given material at a constant temperature (schematic)



## **Prediction of Creep Strength**

Fig. 7.29 Family of schematic creep strain-time curves at various stress levels for a given material tested at the same temperature, showing minimum creep rates



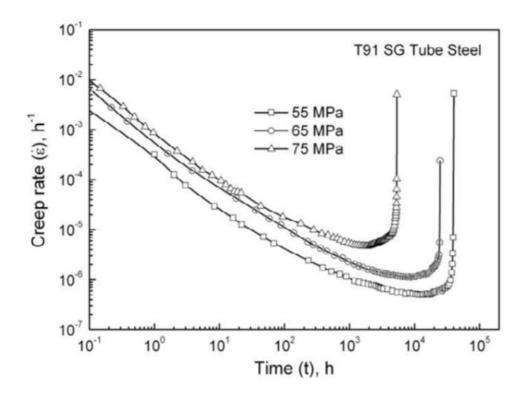


Fig. 4. Typical creep curves showing creep rate-time plots for stress levels 55, 65 and 75 MPa at 923 K.

Low temperature Creep T < 0.3T<sub>m</sub>

Creep deformation

Medium temperature Creep 0.3T<sub>m</sub> <T <0.8T<sub>m</sub>

High temperature Creep T > 0.8Tm

#### LOW TEMPERATURE CREEP

Creep at low temperatures (< 0.25Tmp) is generally transient, achieving creep exhaustion during stage 1 (primary creep) and never reaching stage 2 (secondary creep). Thermal energy required for dynamic recovery is not available in the temperature ranges of interest; therefore, the material experiences creep exhaustion or creep saturation.

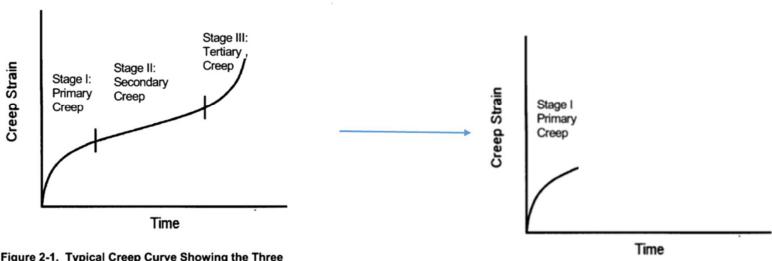


Figure 2-1. Typical Creep Curve Showing the Three Stages of Creep

Primary or transient creep is often described by the following empirical power law equation

$$\varepsilon = At^n$$

$$\varepsilon^{\cdot} = A(n-1)t^{n-1} = Bt^{n-1}$$

where

ε — strain

A — a constant

n — time exponent

t — time

The constant A is reportedly dependent on microstructure and temperature

### **Andrade Law**

$$arepsilon = arepsilon_0 + eta t^{1/3}$$

$$\varepsilon^{\cdot} = At^{-2/3}$$

where  $\varepsilon_0$  is the instantaneous strain,  $\beta$  is a constant and t is time. Equation is in accordance with the time law of creep proposed by Andrade, known as Andrade's  $\beta$ -flow.

Creep mechanisms can be visualized by using superposition of various strain-time curves as shown in Fig. 8.5. An empirical relation which describes the strain-time relation is:

$$\varepsilon = \varepsilon_i \left( 1 + \beta t^{1/3} \right) \exp(kt) \tag{8.2}$$

## Transient creep may also follow a logarithmic fit of the type

$$\varepsilon = A' + B \ln(t)$$

where

ε instantaneous plastic and creep strain

A'and B — creep constants

t — time measured in hours

In comparison to the normal creep equation, the logarithmic creep behavior is usually described by

$$\varepsilon = \varepsilon_0 + \alpha \ln(1 + \gamma t),$$

where  $\alpha$  and  $\gamma$  are constants. This equation indicates that over a long period of time, the strain rate of deformation tends to become zero. Such an equation, as discussed in the previous section, would be useful for describing exhaustion creep.

## primary or transient creep:

- Andrade- $\beta$  flow (or 1/3 rd law) :  $\epsilon_p = \beta t^{1/3} \iff \text{problem as } t \to 0$
- Garofalo / Dorn Equation :  $\varepsilon_p = \varepsilon_t (1 e^{-rt})$ , r is related to  $\frac{\dot{\varepsilon}_i}{\dot{\varepsilon}_s}$

#### **Medium TEMPERATURE CREEP**

The Bailey-Orowan equation

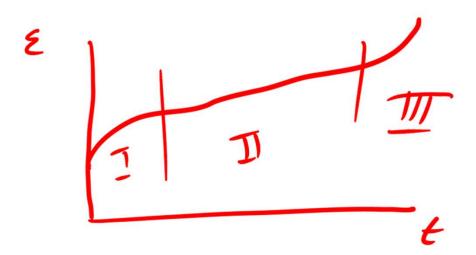
$$\dot{\varepsilon}_{\rm s} = R/H$$

$$R = -(\partial \sigma/\partial t)_{\epsilon}$$

$$R = -(\partial \sigma/\partial t)_{\varepsilon}$$

$$H = (\partial \sigma/\partial \varepsilon)_{t}$$

## **Medium TEMPERATURE CREEP**



# Chapter 7 Recrystallization

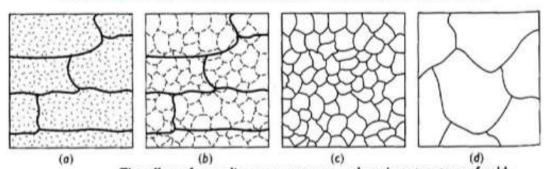
Dynamic recrystallization

Annealing is a heat treatment designed to eliminate the effects of cold working. The properties of a metal may revert back to the precold-worked states by Annealing, through recovery, recrystallization and grain growth.

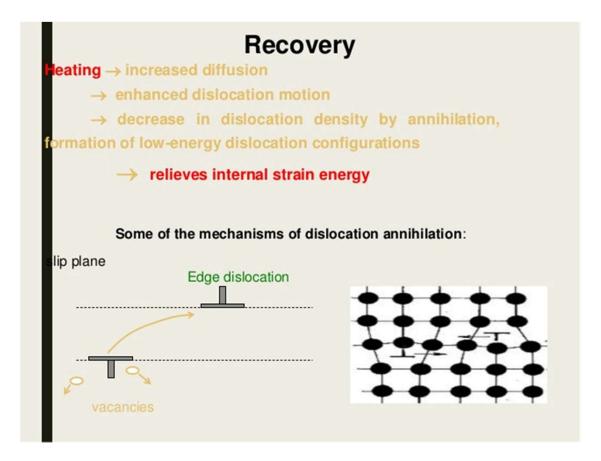
Recovery: the relief of some of the internal strain energy of a previously cold-worked material.

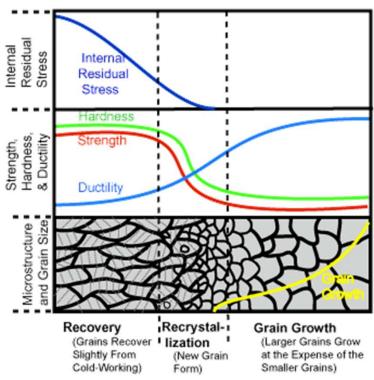
Recrystallization: the formation of a new set of strain-free grains within a previously cold-worked material.

Grain Growth: the increase in average grain size of a polycrystalline material. An elevated temperature heat treatment (annealing) is needed for these 3-processes.



The effect of annealing temperature on the microstructure of coldworked metals: (a) cold worked, (b) after recovery, (c) after recrystallization, and (d) after grain growth.





During this stage, the steady state is achieved because of an approximate balance between two opposing factors: the strain hardening that tends to reduce the creep rate and the softening or recovery process that tends to increase it

σ=cte , σ=f(t, ε) → 
$$d\sigma = \frac{\partial \sigma}{\partial t} \partial t + \frac{\partial \sigma}{\partial \varepsilon} \partial \varepsilon = 0$$
, or,  $\frac{\partial \sigma}{\partial \varepsilon} \partial \varepsilon = -\frac{\partial \sigma}{\partial t} \partial t$ ;  
∴  $\dot{\varepsilon}_{s} = \frac{d\varepsilon}{dt} = -\frac{\partial \sigma/\partial t}{\partial \sigma/\partial \varepsilon} = \frac{r}{h}$ 

Microstructural softening due to recovery process in the low-temperature region includes cross-slip of screw dislocations while that at a homologous temperature above 0.5 includes rearrangement and annihilation of dislocations and climbing of edge dislocations.

 $Y = -\frac{\partial U}{\partial t} = A \left(\frac{d}{C}\right)^{2} \cdot Osp$   $Y = -\frac{\partial U}{\partial t} = A \left(\frac{d}{C}\right)^{2} \cdot Osp$   $Y = -\frac{\partial U}{\partial t} = A \left(\frac{d}{C}\right)^{2} \cdot Osp$   $Y = -\frac{\partial U}{\partial t} = A \left(\frac{d}{C}\right)^{2} \cdot Osp$   $Y = -\frac{\partial U}{\partial t} = A \left(\frac{d}{C}\right)^{2} \cdot Osp$   $Y = -\frac{\partial U}{\partial t} = A \left(\frac{d}{C}\right)^{2} \cdot Osp$   $Y = -\frac{\partial U}{\partial t} = A \left(\frac{d}{C}\right)^{2} \cdot Osp$   $Y = -\frac{\partial U}{\partial t} = A \left(\frac{d}{C}\right)^{2} \cdot Osp$   $Y = -\frac{\partial U}{\partial t} = A \left(\frac{d}{C}\right)^{2} \cdot Osp$   $Y = -\frac{\partial U}{\partial t} = A \left(\frac{d}{C}\right)^{2} \cdot Osp$   $Y = -\frac{\partial U}{\partial t} = A \left(\frac{d}{C}\right)^{2} \cdot Osp$   $Y = -\frac{\partial U}{\partial t} = A \left(\frac{d}{C}\right)^{2} \cdot Osp$   $Y = -\frac{\partial U}{\partial t} = A \left(\frac{d}{C}\right)^{2} \cdot Osp$   $Y = -\frac{\partial U}{\partial t} = A \left(\frac{d}{C}\right)^{2} \cdot Osp$   $Y = -\frac{\partial U}{\partial t} = A \left(\frac{d}{C}\right)^{2} \cdot Osp$   $Y = -\frac{\partial U}{\partial t} = A \left(\frac{d}{C}\right)^{2} \cdot Osp$   $Y = -\frac{\partial U}{\partial t} = A \left(\frac{d}{C}\right)^{2} \cdot Osp$   $Y = -\frac{\partial U}{\partial t} = A \left(\frac{d}{C}\right)^{2} \cdot Osp$   $Y = -\frac{\partial U}{\partial t} = A \left(\frac{d}{C}\right)^{2} \cdot Osp$   $Y = -\frac{\partial U}{\partial t} = A \left(\frac{d}{C}\right)^{2} \cdot Osp$   $Y = -\frac{\partial U}{\partial t} = A \left(\frac{d}{C}\right)^{2} \cdot Osp$   $Y = -\frac{\partial U}{\partial t} = A \left(\frac{d}{C}\right)^{2} \cdot Osp$   $Y = -\frac{\partial U}{\partial t} = A \left(\frac{d}{C}\right)^{2} \cdot Osp$   $Y = -\frac{\partial U}{\partial t} = A \left(\frac{d}{C}\right)^{2} \cdot Osp$   $Y = -\frac{\partial U}{\partial t} = A \left(\frac{d}{C}\right)^{2} \cdot Osp$   $Y = -\frac{\partial U}{\partial t} = A \left(\frac{d}{C}\right)^{2} \cdot Osp$   $Y = -\frac{\partial U}{\partial t} = A \left(\frac{d}{C}\right)^{2} \cdot Osp$   $Y = -\frac{\partial U}{\partial t} = A \left(\frac{d}{C}\right)^{2} \cdot Osp$   $Y = -\frac{\partial U}{\partial t} = A \left(\frac{d}{C}\right)^{2} \cdot Osp$   $Y = -\frac{\partial U}{\partial t} = A \left(\frac{d}{C}\right)^{2} \cdot Osp$   $Y = -\frac{\partial U}{\partial t} = A \left(\frac{d}{C}\right)^{2} \cdot Osp$   $Y = -\frac{\partial U}{\partial t} = A \left(\frac{d}{C}\right)^{2} \cdot Osp$   $Y = -\frac{\partial U}{\partial t} = A \left(\frac{d}{C}\right)^{2} \cdot Osp$   $Y = -\frac{\partial U}{\partial t} = A \left(\frac{d}{C}\right)^{2} \cdot Osp$   $Y = -\frac{\partial U}{\partial t} = A \left(\frac{d}{C}\right)^{2} \cdot Osp$   $Y = -\frac{\partial U}{\partial t} = A \left(\frac{d}{C}\right)^{2} \cdot Osp$   $Y = -\frac{\partial U}{\partial t} = A \left(\frac{d}{C}\right)^{2} \cdot Osp$   $Y = -\frac{\partial U}{\partial t} = A \left(\frac{d}{C}\right)^{2} \cdot Osp$   $Y = -\frac{\partial U}{\partial t} = A \left(\frac{d}{C}\right)^{2} \cdot Osp$   $Y = -\frac{\partial U}{\partial t} = A \left(\frac{d}{C}\right)^{2} \cdot Osp$   $Y = -\frac{\partial U}{\partial t} = A \left(\frac{d}{C}\right)^{2} \cdot Osp$   $Y = -\frac{\partial U}{\partial t} = A \left(\frac{d}{C}\right)^{2} \cdot Osp$   $Y = -\frac{\partial U}{\partial t} = A \left(\frac{d}{C}\right)^{2} \cdot Osp$   $Y = -\frac{\partial U}{\partial t} = A \left(\frac{d}{C}\right)^{2} \cdot Osp$   $Y = -\frac{\partial U}{\partial t} = A \left(\frac{d}{C}\right)^{2} \cdot Osp$   $Y = -\frac{\partial U}{\partial t} =$ 

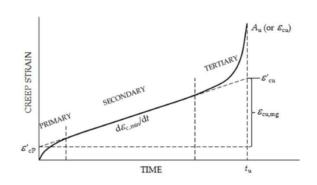
- total creep curve :  $\epsilon = \epsilon_o + \epsilon_p + \epsilon_s$ 

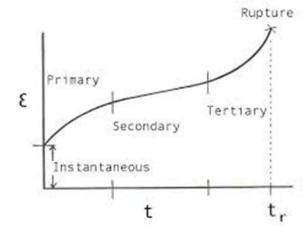
 $\varepsilon_o$  = instantaneous strain at loading (elastic, anelastic and plastic)

 $\epsilon_s$  = steady-state creep strain (constant-rate viscous creep ) =  $\dot{\epsilon}_{s}t$ 

 $\epsilon_p$  = primary or transient creep : Andrade- $\beta$  flow (or 1/3 rd law) :  $\beta t^{1/3}$ 







## Garofalo equation:

$$arepsilon = arepsilon_0 + arepsilon_t (1 - e^{- \, rt}) + \dot{arepsilon}_s t$$

$$\varepsilon = \varepsilon_i + \varepsilon_t (1 - \exp(rt)) + t \dot{\varepsilon}_{ss}$$

$$arepsilon = arepsilon_0 + eta t^{1/3} + \dot{arepsilon}_s t + \gamma t^3,$$

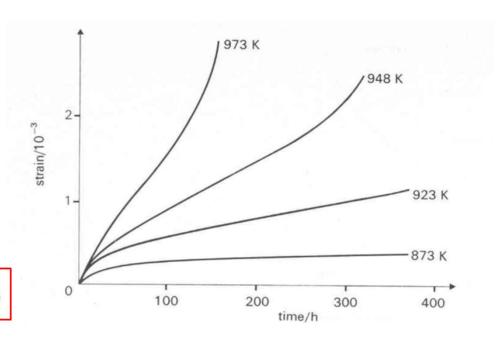
where  $\mathbf{y}t^3$  describes the tertiary component of the creep curve

$$\varepsilon = \varepsilon_i + B\sigma^m t + D\sigma^\alpha (1 - \exp(\beta t))$$

## **High TEMPERATURE CREEP**

$$\varepsilon = \varepsilon_0 + \gamma t^n$$

$$\varepsilon = B + C \exp(\gamma t)$$



Proposed by	Formula	Comments
Andrade (1910, 1914)	$\varepsilon_c = Bt^{1/\beta}$	Applicable to primary stage; $\beta = 3$ ;
Lomnitz (1956, 1957)	$\varepsilon_c = A \ln(1 + \alpha t)$	Applicable to primary stage
Modified Lomnitz law	$\varepsilon_c = A + B\log(t) + Ct$	Primary and secondary stages
Norton's law	$\varepsilon_c = A\sigma_a^n t$ or $\varepsilon_c = A\sigma_a^n$	Applicable to secondary stage and n=4-5
Modified Norton's law	$\varepsilon_c = B \left\langle \frac{\sigma_a}{\sigma_{ct}} - 1 \right\rangle^n t \text{ or }$ $\varepsilon_c = B \left\langle \frac{\sigma_a}{\sigma_{ct}} - 1 \right\rangle^n$	Applicable to secondary stage and $\sigma_{ct}$ is the stress threshold to induce steady state creep response.
Griggs and Coles (1958)	$\varepsilon_c = A + Bt^2$	Applicable to tertiary stage
Aydan et al. (2003)	$\varepsilon_c = A \left( 1 - e^{-t/\tau_1} \right) + B \left( e^{t/\tau_2} - 1 \right)$	Applicable to all stages creep leading to failure

 $A, B, C, \alpha, \tau_1, \tau_2$ , and n are constants to be determined from experimental results.  $\sigma_a, \varepsilon_c, \dot{\varepsilon}_c$ , and t are the applied stress, creep strain, strain rate, and time, respectively, hereafter

Equation Form	References	Equation
Time Depo	endence	
Rational $\epsilon_C = at/(1 + bt)$	(Freundenthal, 1936)	(a)
Logarithmic $\epsilon = a + b \ln(t)$ $\epsilon = a + b \ln(1 + ct)$	(Phillips, 1905) Modification of (b)	(b) (c)
Exponential $\epsilon = a + bt - c \exp(-dt)$ $\epsilon_C = at + b[1 - \exp(-ct)]$	(McVetty, 1934) (McVetty, 1934) (Söderberg, 1936)	(d) (e)
Power $\epsilon_C = bt^n$ ; $1/3 < n < 1/2$	(Bailey, 1935)	(f)
Power series $\epsilon_C = at^m + bt^n;  m > 1,  0 < n < 1$ $\epsilon_C = at_m + bt_n + ct_p \dots$	(de Lacombe, 1939) (Graham, 1953)	(g) (h)

 The temperature dependency of creep is often related to thermodynamics and rate processes of solid-state physics, the temperature dependency is often of exponential form.

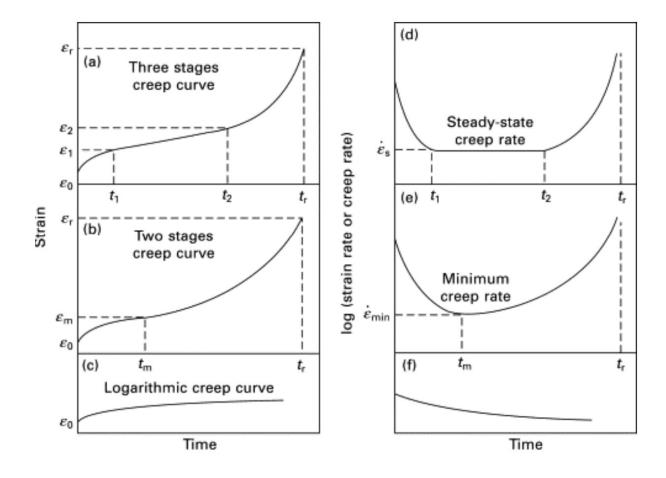
#### **Temperature Dependence**

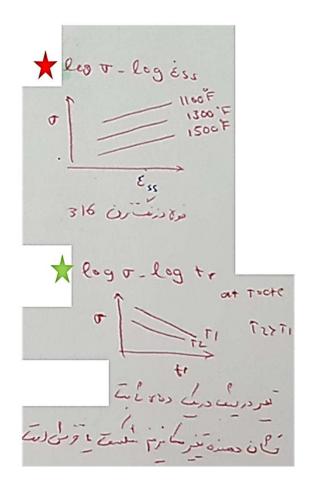
Exponential	(Mott, 1953)	(k)
$\dot{\epsilon}_C = a \exp(-Q/RT)$	, , , ,	(1)
$\epsilon_C = a[t \exp(-Q/RT)]$	(Dorn, 1962)	
$\dot{\epsilon}_C = aT \exp(-Q/RT)$	(Stowell, 1957)	(m)
Rational		
$\epsilon_C = aT^{2/3}f(t)$	(Mott and Nabarro, 1948)	(n)
$\epsilon_C = aTf(t)$	(Smith, 1948)	(o)
$\epsilon_C = f\{T[a + \ln(t)]\}$	(Larson and Miller, 1952)	(p)
$\epsilon_C = f[(T-a)/\ln(t-b)]$	(Manson and Haferd, 1954)	(q)
Hyperbolic-exponential		
$\dot{\epsilon}_C = a \exp(-Q/RT) \sinh(b/RT)$	(Feltham, 1953)	(r)
Other		
$\epsilon_C = cf[t(T - T')^{-B}]$	(Warren, 1967)	(s)

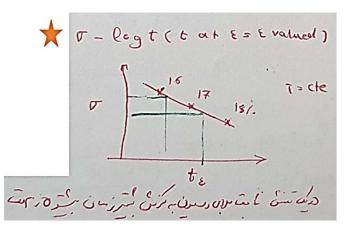
#### Stress Dependence

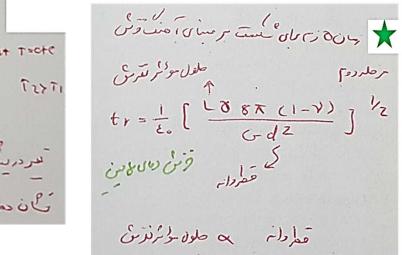
Exponential $\epsilon_C = af(t)\exp(b\sigma)$	(Dorn, 1962)	(t)
$\dot{\epsilon}_C = a \exp(b + c\sigma)$	(Nadai, 1931)	(u)
$\dot{\epsilon}_C = a[\exp(b\sigma) - 1]$	(Söderberg, 1936)	(v)
Power		
$\epsilon_C = af(t)\sigma^b$	(Dorn, 1962)	(w)
$\epsilon_C = at^n \sigma^b$ ; $0 < n < 1$ , $b > 1$ ; Bailey-Norton law	(Bailey, 1935)	(x)
	(Norton, 1929)	
Hyperbolic		
$\dot{\epsilon}_C = a \sinh(b\sigma)$	(Ludwik, 1908)	(y)
	(McVetty, 1943)	
$\dot{\epsilon}_C = a \sinh(b\sigma/RT)$	(Feltham, 1953)	(z)

 $\epsilon$  denotes total strain,  $\epsilon_c$  creep strain,  $\sigma$  stress, T temperature, t time, In the natural logarithm, exp the exponential e, and a, b, c,..., A, B, C,... parameters that may be functions of  $\sigma$ , t, T or they may be constants. Time derivative is denoted by a dot over a symbol (e.g.,  $\epsilon^o$ ). The notation f(x) denotes a function of x.



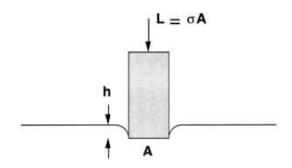




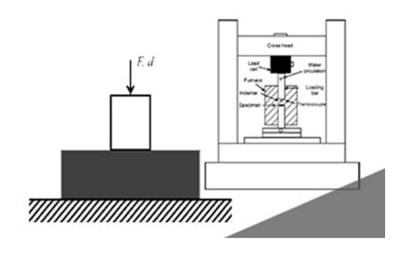


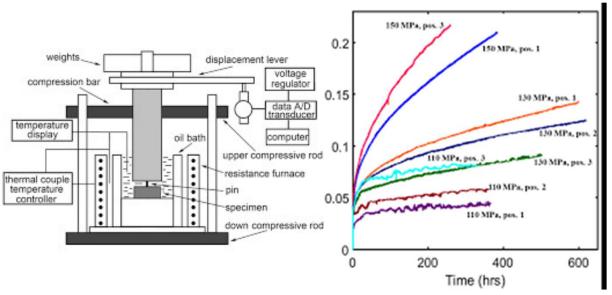
#### **Impression creep**

where a small **cylindrical or spherical indenter** is pressed into the surface of a material under a constant load and temperature. Instead of stretching the entire material like in traditional creep tests, this method measures how much the **indenter sinks** into the material over time.

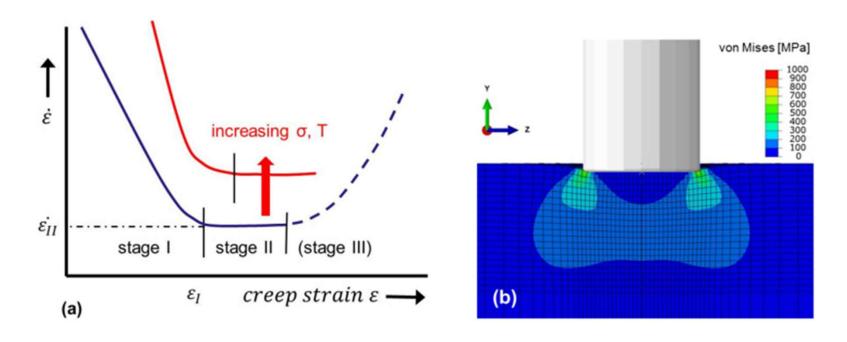


#### **Impression creep**





## New flat-punch indentation creep testing



#### Comparison: Impression Creep vs. Tensile Creep

Feature	Impression Creep	Tensile Creep
Test Type	Indenter pressed into surface	Material pulled in tension
Sample Size	Small/localized	Larger (standard dog-bone or rod)
Stress State	Triaxial (under punch)	Uniaxial
Main Measurement	Penetration depth over time	Elongation (strain) over time
Best for	Welds, coatings, thin films, small zones	Bulk material characterization
Temperature Suitability	Good for high-temperature tests	Also suitable for high temperatures
Ease of Preparation	Simpler for difficult-to-machine materials	Requires machining uniform test specimens
Data Interpretation	Needs conversion to equivalent stress/strain	Direct calculation of strain and rate
Common Materials	Superalloys, welds, nuclear materials, polymers	Metals, ceramics, polymers

#### Creep Under Multiaxial Loading

(text 14-14)

Use Levy-Mises Equations in plasticity

$$\sigma_{\text{eff}} = \frac{1}{\sqrt{2}} \sqrt{(\sigma_1 - \sigma_2)^2 + (\sigma_2 - \sigma_3)^2 + (\sigma_3 - \sigma_1)^2}$$

and 
$$d\epsilon_1 = \frac{d\epsilon_{eff}}{\sigma_{eff}} \left[ \sigma_1 - \frac{1}{2} (\sigma_2 + \sigma_3) \right],$$

since creep is plastic deformation 1/2 appears as in plasticity. Similarly,  $d\epsilon_2$  and  $d\epsilon_3$ .

Dividing by dt, get the corresponding creep-rates,

$$\dot{\varepsilon}_1 = \frac{\aleph_{\text{eff}}}{\sigma_{\text{eff}}} \left[ \sigma_1 - \frac{1}{2} (\sigma_2 + \sigma_3) \right], \text{ etc.}$$

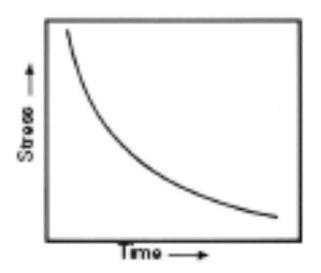
One first determines the uniaxial creep-rate equation,

$$\dot{\varepsilon}_s = A \sigma^n e^{-Q/RT}$$

and assume the same for effective strain-rate :  $\dot{\varepsilon}_{eff} = A \sigma_{eff}^{n} e^{-Q/RT}$ 

so that 
$$\boxed{ \grave{\vartheta}_1 = A \; \sigma_{eff}^{n\text{--}1} \; e^{-Q/RT} \; [\sigma_1 \; \text{--}\; \frac{1}{2} \, (\sigma_2 + \sigma_3)] } \quad \text{etc.}$$

### Stress Relaxation



Stress relaxation in creep refers to the gradual decrease in stress under a condition of constant strain over time due to viscous (time-dependent) deformation in a material.

Here's how it works in context.

During a **creep test**, if the material is loaded and held at a fixed displacement (constant strain), the **internal stress decreases** over time as the material relaxes. This happens because the material undergoes microstructural changes (e.g., dislocation motion, diffusion) that allow it to carry the load with less internal resistance.

#### How Stress Relaxation Affects Creep Behavior

#### 1. Delays Material Failure

- •When stress relaxes, it reduces the internal forces acting on a material.
- •This can **slow down the creep rate**, especially in the **secondary creep stage** (steady-state).
- •Helps avoid premature rupture or deformation.
- 2. Reduces Localized Stresses
- 3. Influences Design Life

#### **Stress Relaxation**

- (1) Elastic strain,  $\varepsilon_e$ ;
- (2) Time-independent plastic strain,  $\varepsilon_p$ , that occurs on loading;
- (3) Time-dependent creep strain,  $\varepsilon_c$ .

The total strain after loading is therefore given as:

$$\varepsilon_{\rm t} = \varepsilon_{\rm e} + \varepsilon_{\rm p} + \varepsilon_{\rm c} = {\rm constant}$$
 (7.72)

$$0 = \frac{d\varepsilon_{e}}{dt} + 0 + \frac{d\varepsilon_{c}}{dt}; \quad \text{or,} \quad \frac{d\varepsilon_{e}}{dt} = -\frac{d\varepsilon_{c}}{dt}$$

But for a linear elastic material,  $\varepsilon_e = \sigma/E$ , where  $\sigma$  is the instantaneous stress, which is a function of time, and E is the elastic modulus. Hence,

$$\frac{\mathrm{d}\varepsilon_{\mathrm{e}}}{\mathrm{d}t} = \frac{1}{E} \frac{\mathrm{d}\sigma}{\mathrm{d}t} \tag{7.74}$$

Substituting (7.74) into (7.73) and then integrating with respect to time t, one obtains

$$\int_{\varepsilon_{p}}^{\varepsilon_{c}} \frac{d\varepsilon_{c}}{dt} dt = -\frac{1}{E} \int_{\sigma_{i}}^{\sigma} \frac{d\sigma}{dt} dt$$

$$\therefore \varepsilon_{c} - \varepsilon_{p} = \frac{\sigma_{i} - \sigma}{E}$$
(7.75)

where  $\varepsilon_p$  is the time-independent plastic strain at time t=0, when relaxation begins, and  $\sigma_i$  is the initial stress at the same instant. Equation (7.75) shows that as  $\sigma$  decreases  $\varepsilon_c$  increases. Creep therefore occurs under conditions of decreasing stress.

$$\frac{d\varepsilon_{\rm c}}{{\rm d}t} = \dot{\varepsilon}_{\rm s} = A_2' \sigma^n$$

$$\frac{1}{E}\frac{\mathrm{d}\sigma}{\mathrm{d}t} = -A_2'\sigma^n\tag{7.77}$$

Equation (7.77) is the differential equation for the idealized case of stress relaxation where steady-state creep at a low stress level and a fixed total strain,  $\varepsilon_t$ , are assumed. Integrating (7.77), we get

$$\int \frac{d\sigma}{\sigma^n} = -A_2' E \int dt$$

$$-\frac{1}{(n-1)\sigma^{n-1}} = -A_2' E t + C$$
(7.78)

where C is the integration constant. At the start of testing, i.e. at time t = 0, the initial stress  $\sigma = \sigma_i$ . From this condition, C can be evaluated from (7.78):

$$C = -\frac{1}{(n-1)\sigma_{\rm i}^{n-1}} \tag{7.79}$$

Substitution of the value of C from (7.79) into (7.78) gives the relation between stress and time in stress relaxation as follows:

$$\frac{1}{\sigma^{n-1}} = \frac{1}{\sigma_{i}^{n-1}} + A_2' E(n-1)t \tag{7.80}$$

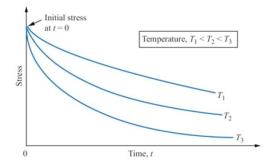


Fig. 7.41 Schematic stress-relaxation curves for a given material at various temperatures for the same initial stress, showing the rate of decrease of stress increases with increasing temperature

$$E_{i} = \underbrace{E}_{e} + E_{p} = cte$$

$$E_{i} = \underbrace{E}_{e} + E_{p} = cte$$

$$\underbrace{E_{i}}_{e} = \underbrace{\frac{\nabla_{t}}{E}}_{e} + E_{p} = cte$$

$$\underbrace{\frac{dE_{i}}{dt}}_{dt} = \underbrace{\frac{d\nabla_{t}}{dt}}_{dt} + \underbrace{\frac{dE_{p}}{dt}}_{dt} = 0$$

$$\underbrace{\frac{d\nabla_{t}}{dt}}_{e} = -\underbrace{\frac{d\nabla_{t}}{dt}}_{e} = -\underbrace{\frac{$$

 $\frac{1}{\sigma^{n-l}} = \frac{1}{\sigma^{n-l}} + ce(n-l)t$ 

**7.16.2**. A steel bolt clamping two rigid plates together is kept over a period of 5 years at a constant temperature of 650 °C. It is found that the stress ( $\sigma$  in MPa) dependence of steady-state creep rate ( $\dot{\varepsilon}_{\rm s}$  in s<sup>-1</sup>) for this steel at 650 °C is given by  $\dot{\varepsilon}_{\rm s} = {\rm constant}\,(\sigma)^5$ . Test of the bolt steel at this temperature indicates that  $\dot{\varepsilon}_{\rm s} = 7 \times 10^{-9}~{\rm s}^{-1}$  at a stress of 41 MPa. If Young's modulus of the steel at 650 °C is

124 GPa and the stress in the bolt must not drop below 3 MPa during the 5 years, determine the initial stress to which the bolt must be tightened.

#### Solution

Given that  $\dot{\varepsilon}_{\rm s}={\rm constant}\,(\sigma)^5$ , at 650 °C. Further, it is indicated that when the stress is  $\sigma=41$  MPa, the steady-state creep rate is  $\dot{\varepsilon}_{\rm s}=7\times10^{-9}~{\rm s}^{-1}$ , therefore

Constant, say, 
$$A'_2 = \frac{\dot{\varepsilon}_s}{\sigma^5} = \frac{7 \times 10^{-9}}{(41)^5} \text{ MPa}^{-5} \text{ s}^{-1}$$
  
= 6.04197 × 10<sup>-17</sup> MPa<sup>-5</sup> s<sup>-1</sup>

Since it is given that the dependence of steady-state creep rate  $(\dot{\epsilon}_s)$  on stress  $(\sigma)$  is governed by power relation, so the relation between stress and time in stress relaxation will be given by (7.80), which is:

$$\frac{1}{\sigma^{n-1}} = \frac{1}{\sigma_i^{n-1}} + A_2' E(n-1)t$$

where

- the stress remaining after 5 years = 3 MPa;
- n the power index of stress ( $\sigma$ ) in the relation between steady-state creep rate ( $\dot{c}_s$ ) and stress ( $\sigma$ ) = 5;
- $\sigma_i$  the initial stress in MPa, which is to be determined;
- $A_2'$  the constant in the relation between steady-state creep rate  $(\dot{e}_s)$  and stress  $(\sigma) = 6.04197 \times 10^{-17} \text{ MPa}^{-5} \text{ s}^{-1}$ ;
- E Young's modulus of the steel at 650 °C =  $124 \times 10^3$  MPa;
- the time in seconds

= 
$$(5 \times 365.25 \times 24 \times 3600)$$
 s =  $157.788 \times 10^6$  s;

Hence, substituting the above values into (7.80), we get:

$$\begin{split} \frac{1}{\sigma_{\rm i}^{5-1}} &= \frac{1}{\left(3\right)^{5-1}} - \left(6.04197 \times 10^{-17}\right) \times \left(124 \times 10^{3}\right) \\ &\times (5-1) \times \left(157.788 \times 10^{6}\right) \\ &= 7.617 \times 10^{-3} \text{ MPa}^{-4}. \end{split}$$

Or, 
$$\sigma_i^4 = \frac{1}{7.617 \times 10^{-3}} = 131.285 \text{ MPa}^4;$$

$$\sigma_i = (131.285)^{\frac{1}{4}} MPa = 3.385 MPa$$
.

High Temp Behavior of Materials:

Mechanical degradation Chemical Degradation

- Gas Turbine and jet Turbine
- Nuclear reactors
- Power plants
- Spacecraft
- Chemical processing

#### factors that influencing functional life of components at elevated temp?

- 1) Creep
- 2) Corrosion
- 3) High temperature fracture
- 4) Thermo mechanical Fatigue
- 5) Micro structural changes
- 6) Metallurgical ageing and metallurgical stability
- 7) Interaction of all above with each other

## Design Considerations to avoid Creep

- Reduce the effect of grain boundaries:
  - Use single crystal material with large grains.
  - Addition of solid solutions to eliminate vacancies.
- Employ materials of high melting temperatures.
- Consult Creep Test Data during materials Selection
  - Type of service application
  - Set adequate inspection intervals according to life expectancy.

## Common Materials and Their Creep Properties

#### Materials commonly studied for creep (metals, ceramics, polymers)

Creep behavior is studied in various materials, with metals like steel and nickel being common due to their applications in high-temperatures; ceramics and polymers also exhibit unique creep properties under prolonged stress.

#### Comparison of creep resistance in different materials

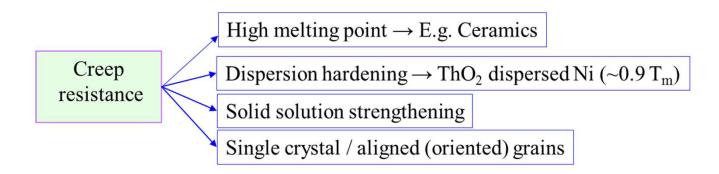
Generally, metals exhibit higher creep resistance under high stresses and temperatures, while ceramics show better stability but can be brittle. Polymers often have high creep rates due to their molecular structure.

#### Case studies of materials with notable creep characteristics

Case studies include superalloys in jet engines that withstand high temperatures while maintaining their strength, and polymer blends that showcase increased longevity in automotive applications.



$$\epsilon_{\textit{SS}}^{\textit{ceramics}} \ < \epsilon_{\textit{SS}}^{\textit{metals}} \ << \epsilon_{\textit{SS}}^{\textit{polymers}}$$



## Rules for Increasing Creep Resistance

- Large Grain Size (directionally solidified superalloys)
- Low Stacking Fault Energy (Cu vs Cu-Al alloys)
- Solid Solution Alloying (Al vs Al-Mg alloys)
- Dispersion Strengthening (Ni vs TD-Ni)

### Parameters affects the creep

- 1- Microstructure (grain size, columnar grain)
- 2- Chemical composition (solid solution and precipitates) and purity
- 3- Melting temperature
- 4- Production technique

عرامل موکر و قری دارند و سسمامه و کارند و دارند و دار

#### Effect of structure and properties on creep resistance:

- $\varepsilon$  ↑ with: ↑ applied stress, ↑ diffusivity ( $\downarrow$  activation energy),  $\downarrow$  grain size
- For a given application T, use of higher  $T_{mp}$  material will  $\downarrow$  diffusivity and correspondingly  $\downarrow \epsilon_{ss}$
- In general:
- Diffusivities in bcc metals >> diffusivities in fcc metals
- if we have a bcc metal and an fcc metal with the same  $T_{mp}$ , then  $\epsilon { heta} \, bcc > \epsilon { heta} \, fcc$
- $\uparrow$  grain size,  $\downarrow \epsilon$  for diffusion controlled creep but does not have any influence on the dislocation creep mechanism.
- For dislocation glide mechanism: ↑ in grain size will ↑ε•

## Alloys for high-temperature use

(turbines in jet engines, hypersonic airplanes, nuclear reactors, etc.)

Creep is generally minimized in materials with:

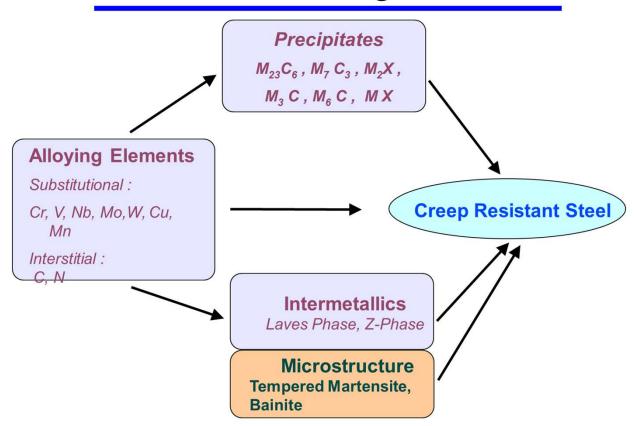
- ✓ High melting temperature
- ✓ High elastic modulus
- ✓ Large grain sizes (inhibits grain boundary sliding)
- ✓ Stainless steels
- ✓ Refractory metals (containing elements of high melting point, like Nb, Mo, W, Ta)
- ✓ "Superalloys" (Co, Ni based: solid solution hardening and secondary phases)

2477 °C 2896 °C 3695 °C 3290 °C

# Resistance to Creep

- ⇒ Solid solution hardening
- ⇒ Precipitate hardening
- → Microstructure

## Heat Resisting Steel



## Creep resistance alloys

- 1- superalloy
- 2- stainless steel (ferritic and austenitic matrix): 9-12 % Cr, Mo, V (9Cr-1Mo-0.2V steel )

with temperature up to 550 °C and 650 °C, respectively

- 3- high melting point metals
- 4- cast-iron
- 5-aluminum

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क्षिर हेरे ने में !! निरंकर देवन पाति १० प्र प्राचित कराति । कर्ला १३ निरंकर	650°C [
AFSI 310 in obeing, 46 [ 0, 18 con 1 0 10 1 0 10 6 cr-Ni-Mos 6 in 1 2 16 6 00 00 00 000 000 000 000 000 000 0	650-800 "
durage il or L CY-Ni-MO son LI Compression TV [IV LOS son	800 - 1000°C
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#### Creep resistance alloys

ع - فوق د ۲۰-Mo (علول طاف على سرآس كرى) م درم هاى معار درع لاستُعام ما Tm (w) = 3410° c ) Ta = 2996° c , Mo = 2610° c 7a -W-no bysting heat sim jes ice dires Mg, AI, Ti of cite chi-A



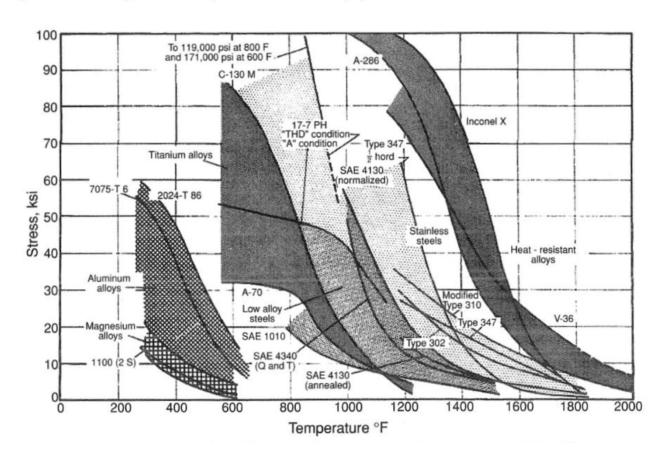
## West Virginia University

## **Creep Resist Materials**

400 to 575°C	Low alloy ferritic steels Titanium alloys (up to 450°C) Inconels and nimonics	Heat exchangers Steam turbines Gas turbine compressors				
575 to 650°C	Iron-based super-alloys Ferritic stainless steels Austenitic stainless steels Inconels and nimonics	Steam turbines Superheaters Heat exchangers				
650 to 1000°C	Austenitic stainless steels Nichromes, nimonics Nickel based super-alloys Cobalt based super-alloys	Gas turbines Chemical and petrochemical reactors Furnace components Nuclear construction				
Above 1000°C	Refractory metals: Mo, W, Ta Alloys of Nb, Mo, W, Ta Ceramics: Oxides Al <sub>2</sub> O <sub>3</sub> , MgO etc. Nitrides, Carbides: Si <sub>3</sub> N <sub>4</sub> , SiC	Special furnaces - Experimental turbines				

Mechanical & Aerospace Engineering

## Alloys for high temperature applications



A **superalloy**, or **high-performance alloy**, is an <u>alloy</u> with the ability to operate at a high fraction of its melting point.

Several key characteristics of a superalloy are excellent <u>mechanical strength</u>, resistance to <u>thermal creep deformation</u>, and resistance to corrosion or oxidation.

The crystal structure is typically <u>face-centered cubic</u> (FCC) <u>austenitic</u>.

Superalloys develop high temperature strength through solid solution strengthening and precipitation strengthening from secondary phase precipitates such as gamma prime and carbides.

Oxidation or corrosion resistance is provided by elements such as <u>aluminium</u> and <u>chromium</u>.

- 1- **Ni-based superalloys** have emerged as the material of choice for these applications.
- 2- **Co-based superalloys** potentially possess superior hot corrosion, oxidation, and wear resistance as compared to Ni-based superalloys.

### 3-Fe-based superalloy

The use of steels in superalloy applications is of interest because certain steel alloys have showed creep and oxidation resistance similar to that of Ni-based superalloys, while being far less expensive to produce.

Super alloys including not only metals, but also nonmetals;

<u>chromium</u>, <u>iron</u>, <u>cobalt</u>, <u>molybdenum</u>, <u>tungsten</u>, <u>tantalum</u>, <u>aluminium</u>, <u>titanium</u>, <u>zirconium</u>, <u>niobium</u>, <u>rhenium</u>, <u>yttrium</u>, <u>vanadium</u>, <u>carbon</u>, <u>boron</u> or <u>hafnium</u> are some examples of the alloying additions used.

Each of these additions has been chosen to serve a particular purpose in optimizing the properties for high temperature application.

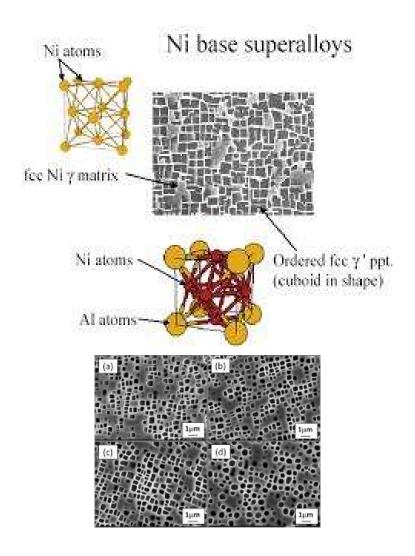
#### Ni-based Superalloy Compositions

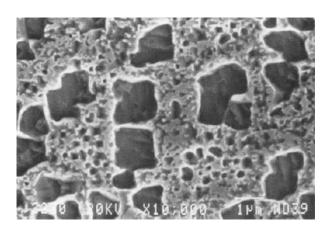
Element	Composition range (Weight %)	Purpose							
Ni, Fe, Co	50-70%	These elements form the base matrix $\gamma$ phase of the superalloy. Ni is necessary because it also forms $\gamma'$ (Ni <sub>3</sub> Al). Fe and Co have higher melting points than Ni and offer solid solution strengthening. Fe is also much cheapr than Ni or Co.							
Cr	5-20%	Cr is necessary for oxidation and corrosion resistance; it forms a protective oxide Cr <sub>2</sub> O <sub>3</sub>							
IA	0.5-6%	All is the main $\gamma'$ former. It also forms a protective oxide Al <sub>2</sub> O <sub>3</sub> , which provides oxidation resistance at higher temperature than $Cr_2O_3$							
Ti	1-4%	Ti forms $\gamma'$							
С	0.05-0.2%	MC and $M_{23}C_6$ (M=metal) carbides are the strengthening phase in the absence of $\gamma$ '							
B,Zr	0-0.1%	Boron and zirconium provide strength to grain boundaries. This is not essential in single-crystal tubine blades, because there are no grain boundaries							
Nb	0-5%	Nb can form $\gamma$ ", a strengthening phase at lower (below 700 °C) temperatures							
Re, W, Hf, Mo, Ta	1-10%	Refractory metals, added in small amounts for solid solution strengthening (and carbide formation). They are heavy, but have extremely high melting points							

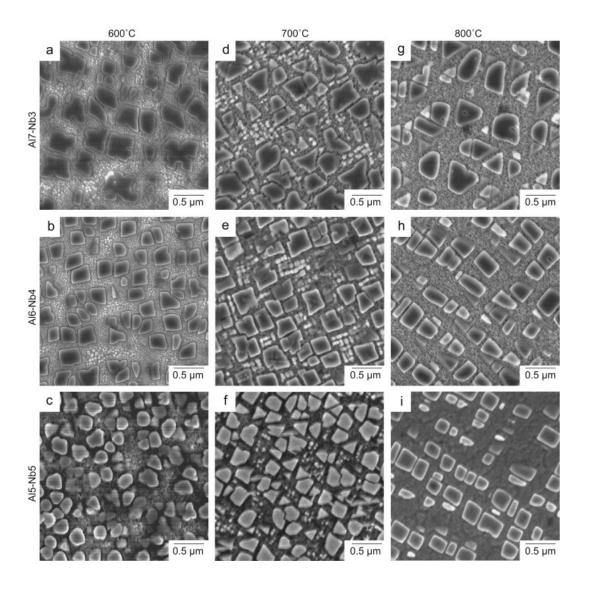
#### Superalloy Phases

Phase	Classification	Structure	Composition(s)	Appearance	Effect
γ	matrix	disordered	Ni, Co, Fe and other elements in solid	The background for other precipitates	The matrix phase, provides ductility and a structure for precipitates
		FCC	solution	cubes, rounded cubes, spheres, or	
γ	GCP	L1 <sub>2</sub> (ordered FCC)	Ni <sub>3</sub> (Al,Ti)	platelets (depending on lattice mismatch)	The main strengthening phase. $\gamma'$ is coherent with $\gamma$ , which allows for ductility.
Carbide	Carbide	FCC	$mC$ , $m_{23}C_6$ , and $m_6C$ ( $m$ =metal)	string-like clumps, like strings of pearls	There are many carbides, but they all provide dispersion strengthening and grain boundary stabilization
γ"	GCP	DO <sub>22</sub> (ordered BCT)	Ni <sub>3</sub> Nb	very small disks	This precipitate is coherent with $\gamma'$ . It is the main strengthening phase in IN-718, but $\gamma''$ dissolves at high temperatures
η	GCP	DO <sub>24</sub> (ordered HCP)	Ni <sub>3</sub> Ti	may form cellular or Widmanstätten patterns	The phase is not the worst, but it's not as good as $\gamma$ '. It an be useful in controlling grain boundaries
δ	not close- packed	orthorhombic	Ni <sub>3</sub> Nb	acicular (needle-like)	The main issue with this phase is that it's not coherent with $\gamma$ , but it is not inherently weak. It typically forms from decomposing $\gamma$ ", but sometimes it's intentionally added in small amounts for grain boundary refinement
σ	TCP	tetrahedral	FeCr, FeCrMo, CrCo	elongaged globules	This TCP is usually considered to have the worst mechanical properties. [18] It is never desirable for mechanical properties
μ	TCP	hexagonal	Fe <sub>2</sub> Nb, Co <sub>2</sub> Ti, Fe <sub>2</sub> Ti	globules or platelets	This phase has typical TCP issues. It is never desirable for mechanical properies
Laves	TCP	rhombohedral	(Fe,Co) <sub>7</sub> (Mo,W) <sub>6</sub>	coarse Widmanstätten platelets	This phase has typical TCP issues. It is never desirable for mechanical properies

- -The  $\gamma$ ' phase is a cubic L12-structure Ni3(Al, Ti, Ta, Nb) phase that produces cuboidal precipitates. Superalloys often have a high (60-75%) volume fraction of  $\gamma$ ' precipitates.  $\gamma$ ' precipitates are coherent with the parent  $\gamma$  phase, and are resistant to shearing due to the development of an <u>anti-phase boundary</u> when the precipitate is sheared.
- -The  $\gamma$ " phase is a tetragonal Ni3Nb or Ni3V structure. The  $\gamma$ " phase, however, is unstable above 650 °C, so  $\gamma$ " is less commonly used as a strengthening phase in high temperature applications.
- -Carbides are also used in polycrystalline superalloys to inhibit grain boundary sliding.





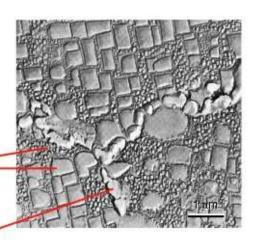


## SUPERALLOYS

## STRENGTHENING MECHANISM

Three strengthening mechanisms are used in Ni superalloys:

- · Solid solution hardening
- · Coherent precipitate hardening
- · Carbide phases on grain boundaries



Examples of such alloys are Hastelloy, Inconel, Waspaloy, Rene alloys, Incoloy, MP98T, TMS alloys, and CMSX single crystal alloys.

# Composition of some high temperature alloys

Alloy	C	Cr	Ni	Mo	Co	W	Cb	Ti	Al	Fe	Other
				F	erritic s	teels		1.0			
1.25 Cr-Mo	0.10	1.25	_	0.50						Bal.	
5 Cr-Mo	0.20	5.00	_	0.50						Bal.	
Greek Ascoloy	0.12	13.0	2.0			3.0				Bal.	
				Au	stenitic	steels				Talig	bir
316	0.08	17.0	12.0	2.50		-41-				Bal.	2011
16-25-6	0.10	16.0	25.0	6.00						Bal.	
A-286	0.05	15.0	26.0	1.25				1.95	0.2	Bal.	
				Nick	el-base	d alloys					144
Astroloy	0.06	15.0	56.5	5.25	15.0			3.5	4.4	1	11.00
Inconel	0.04	15.5	76.0							7.0	
Inconel 718	0.04	19.0	Bal.	3.0			5.0	0.80	0.60	18.0	
René 41	0.10	19.0	Bal.	10.0	11.0			3.2	1.6	2.0	
Mar-M-200	0.15	9.0	Bal.	_	10.0	12.5	1.0	2.0	5.0		
TRW 1900	0.11	10.3	Bal.	-	10.0	9.0	1.5	1.0	6.3		
Udimet 700	0.15	15.0	Bal.	5.2	18.5			3.5	4.25	1.0	
In-100	0.15	10.0	Bal.	3.0	15.0			4.7	5.5		1.0 V
TD Nickel	_	-	Bal.					64.54	b 7 3		2.0 ThO <sub>2</sub>
				Cob	alt-base	d alloys					Tarle
Vitallium											-Delight
(HS-21)	0.25	27.0	3.0	5.0	Bal.					1.0	
S-816	0.40	20.0	20.0	4.0	Bal.	4.0		4.0		3.0	

#### **Phase Formation**

Adding new elements is usually good because of solid solution strengthening, but engineers need to be careful about which phases precipitate.

Precipitates can be classified as geometrically close-packed (GCP), topologically close-packed (TCP), or carbides. GCP phases are usually good for mechanical properties, but TCP phases are often deleterious. Because TCP phases are not truly close packed, they have few slip systems and are very brittle. They are additionally bad because they "scavenge" elements away from GCP phases.

Many elements that are good for forming  $\gamma'$  or have great solid solution strengthening may precipitate TCPs.

Engineers need to find the balance.

An area of the alloy with TCP phase formation will be weak because

- •the TCP phase has inherently poor mechanical properties
- •the TCP phase is incoherent with the γ matrix
- •the TCP phase is surrounded by a "depletion zone" where there is no γ'
- •the TCP phase usually forms sharp plate or needle-like morphologies which easily

nucleate cracks

